1.Programmer Overview

1.1 Programmer hardware parameters

It is a professional programmer with high cost-effective, made by high-density SMD process, unified operation interface, easy to use, complete function, reliable operation of application software program, super small code, faster execution speed, support multilanguage menu. Supported operating systems: WINXP/WIN7/WIN8/WIN10 operating system.

1.1.1 XGecu T56 Parameters

Note: Be sure to use the original USB cable, if you use HUB, it must be a high quality HUB

- PIC32MZ 32-bit MCU 200MHZ + Xilinx SP6 FPGA structure, USB2.0 HS 480MHZ transmission
- Volume: 12.9cm x 8.5cm x 2.9cm
- 56-pins powerful pins drivers IO design. Maximum operating frequency of 50MHZ for all pins, extremely high reliability.
- Stable and reliable 8P in-circuit programmable ISP interface with wire length of more than 40CM, reliable communication at 25-45MHZ.
- The highest clock frequency can reach up to 40MHZ-50MHZ for 25 series/EMMC in-circuit programming.
- VCC voltage 1.2-6.5V, 64 levels adjustable, VPP voltage 6.5-25V 64 levels adjustable.IO voltage 1.2V-3.6V continuously adjustable. VCC 120MA-320MA multilevel over current protection continuously adjustable. VPP 120MA overcurrent protection.
- Power consumption: 5V <500MA. Static power consumption: 180mA , All chips do not need an external power supply.
- Allow to use an external power supply 5V-5.5V 500MA.
- The programmer has multiple protection for external power supply: over-voltage protection/reverse connection protection/over-current protection/under-voltage prompt.
- Maximum read-write speed can reach up to 25-45MB/s
- Open self-test function, self-test on each pin of VPP/VCC/GND/IO
- Suitable for developers and maintenance personnel, suitable for small batch production, support simultaneously working with 4 Programmers on each computer

1.1.2 T866II Plus Parameters

- PIC24 16-bit MCU 32MHZ, USB1.1 FS 12MHZ transmission
- Volume: 10cm x 6cm x 2.5cm
- 40-pin drive IO design. Non-full drive, IO voltage is not adjustable.
- VCC voltage 1.8-6.5V 32 levels adjustable, VPP voltage 9V-18V 32 levels adjustable. VCC 120MA over current protection, VPP 100MA over current protection.
- Power consumption: 5V <500MA. Static power consumption: 60mA. Without external power supply interface.
- Self-test function, self-test each pin of VPP/VCC/GND/IO
- Suitable for developers and maintenance personnel, can do small batch production for small capacity chips, support simultaneously working with 4 Programmers on each computer.

1.2 Programmer support chips and functions

1.2.1XGecu T56

- 26 27 28 29 37 39 49 50 series parallel ROM, EPROM, EEPROM, Paged EPROM, Flash Maximum capacity 2GBits.
- 24 25 35 45 85 93 95 Serial Series EEPROM, Support 25 FLASH chips: Maximum capacity 2GBits
- Support NAND FLASH: Maximum capacity 256Gbits, NAND can be customized parameters to add new model chips.
- Support SPI NAND: Maximum capacity 8Gbits
- Support EMMC/EMCP: Maximum capacity 256GBits, EMMC/EMCP support one-button cloning, support ISP programming
- Microcontroller Series
- GAL/CPLD programmable logic device programming
- Support VGA tool and VGA ISP programming, Can output VGA/HDMI video test signal, read TV or monitor parameters, and ISP in-circuit programming
- Super performance 54/74F/LS/HC CMOS4000 series integrated circuit logic test, Can test common logic integrated circuit, result can be located to the logic gate circuit, customizable logic vector table, can add new chips to support list.
- Support more packages of DIP42/PLCC44/SOP44/QFP44/TSOP48 on base of TL866
- Support TSOP56/BGA48/BGA63/BGA64/BGA100/BGA153/BGA162/BGA169/BGA221 etc.

1.2.2TL866II Plus

- 26 27 28 29 37 39 49 50 Series Parallel ROM, EPROM, EEPROM, Paged EPROM, Flash Maximum capacity 64MBits.
- 24 25 35 45 85 93 95 Serial Series EEPROM. Support 25FLASH chips maximum capacity 512MBits
- NAND FLASH TSOP48 chips support up to 8Gbits, NAND can be customized parameters to add new model chips.
- Microcontroller Series
- GAL programmable logic device programming
- SRAM test, support common 24 61 62 DS12 series SRAM test, support data line test, address line test, memory cell
 incremental test and cell test.
- Super performance 54/74F/LS/HC CMOS4000 series integrated circuits logic test.
- Can test common logic integrated circuits, test can be located to the logic gate circuit, can customize the logic vector table.

2. Software Installation

2.1 Download and install the application software

Download the XgproVxxxx_setup.exe file from HTTP://www.xgecu.com, and double-click the file to enter the installation interface. As follows: (The installation file contains the contents of this manual.) Click [Install] to start installing the application, and the following screen will pop up: Enter the folder where you want to install. Click [Install] to start the installation of the application



Click [Install], after the file is installed to the hard disk. The USB driver installation dialog box is automatically performed. As below:



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2.2 Device Installation

After the above installation is completed, connect programmer into the USB port and the operating system will discover the hardware as below:



Select [Auto Install Software], click [next] button, it will automatically install until the installation is successfully completed.

(Note: In this process, the driver will change the registry. If the firewall software is installed, please release this software. Windows will also prompt the driver have no digital visa, confirm and continue the installation).

If the automatic installation is not successful, you can also choose to install in < from list or specified location>, USB driver files are



and run the programmer

in the installation directory (D:\xgpro\drv). After installation, double-click the desktop icon

software. Ready to use.

2.3 Firmware FLASH Refresh

When using at the first time or upgrading, you may need to refresh the firmware. In the main menu of the software, do a refresh operation as shown below (**Tools-Reflash firmware**):

Select IC IC Information(No Project opened)	1
W25X80AL @SOIC8 ChipType: EEPROM ChkSun IC Size: 0x100000 Bytes (10	n: 0x0FF0 0000)48576 Bytes)
Set Interface C ZIF socket C ICSP port ICSP_VCC Enable Vcc current Imax:	fault 💌 🧔 8 Bits (° 16 Bits
Address 0 1 2 3 4 5 6 7 8 9 A B C D E F ASCII	A No Programmer Four
1000-6000: FF	VESTIONAL REGISTOR
000-0010: FF	Ecmery Size : Ox
000-0020: FF	Damo running as TL
006-0030: FF	1 Programmer Cont
100-0040: FF	Device 1: TL8561
100-0050: FF	U2B SPEED
100-0060: FF	
106-0078: FF	×
008-0088: FF	
000-0090: FF	firmware. Select: <main menu=""><tools><reflash< td=""></reflash<></tools></main>
008-0008: FF	
000-0080: FF	
000-00C0: FF	1
100-0000: FF	確定
008-00E0: FF	
00-00F0: FF	
100-8108: FF	
00-0110: FF	
008-0120. FF	
100-0130: FF	

LOAD 🖬 SAVE	Ð,	100	ID	ar H	3:00	ð	aut	R	EAD			C	alc	ula	ito	r(T)					8.	1000	El caux	10		10	1	TV					
Select IC												S	yst	em	Se	elf-	che	eck			n(N	lo Pr	ojec	t op	ene	ed)							
		Ĵ	W2	5X8	юA	L @	sc		3			R	efla	asł	n fii	m	va	re IC S	ize:		EEF Ox	PRO	M 000	C Byte	hks s (5um: 104	0x 857	OFFO 6 Byt	000 tes)	00)			
Set Inte	rfac ocke	e et		c	IC	SP	por	t				IC	SP.	V	20	Ena	ble			Ve	c ci	urre	nt Ir	nax:		Defa	ult	~		(6	7 8 Bi	ts	C 16
Address	0	1	2	3	4	5	6	7	8	9	Α	В	С	D	E	F	A	SCI	1			1											
0000-0000	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FI	FF			0.		•••	1											
0000-0010	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FI	FF					•••												
0000-0020	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FI	FF	•																
000-0030	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FI	F																	
000-0040	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FI	FF					+ + +												
000-0050	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FI	FF																	
000-0050	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	F	FF																	
000-0070	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	F	FF																	
0800-0000	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FI	FF	•			<i>.</i>	•••												
0000-0000	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	F	FF					-												
060-0000	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FI	FF			÷•••														
0600-0000	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	F	FF			•••		•••												
0000-0000	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	F	F			***		÷.+.)												
000-00D0	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF			•••		•••												
0300-000	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	. •		• • •		• • •												
0008-00F0	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	F	FF	•																
000-0100	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF																	
000-0110	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FI	F	• •																
000-0120	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	F	FF																	
000-0130	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	F	F			11-		+ + 1												
0000-0140	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FI	FF																	

If there is an error during firmware refresh, it is often because the programmer cannot be reset during the refresh and the programmer cannot do the refresh operation.

The reason of error:

It is usually caused by using an external USB hub. Please do not use an external HUB when refreshing. Please directly connect the programmer to the USB port of your computer to refresh. If it still cannot solve your problem, please try to restart your computer or do the refresh operation on another computer.

3. Quick Start

3.1 Hardware preparation and select the correct chip model

Firstly, please make sure the universal programmer application software and USB driver are correctly installed. Then connect programmer to your PC by using USB cable. At this point, the "POW" power indicator of the programmer keeps on and the "RUN" indicator goes off, that means the power connection is normal and you can go to the next step.

(If the RUN indicator blinks, that means the USB driver is installed incorrectly or don't install the USB device driver) Note: Please be sure to use the original USB cable. If you use HUB, make sure it is the high quality HUB and the USB voltage should not be lower than 4.90V. Low voltage is usually caused by using poor quality USB cable or HUB, that will make the programmer work unstably.

As shown below:

- 1) Click the [Select IC] button, the select Device dialog box pops up.
- 2) In the search IC, type in the IC model (for example W29C020C)
- 3) Select the correct manufactory (if there are more than one)

- 4) Select the correct model. Note: @PLCC32 @TSOP32 refer to the IC package, none: dual-in-line package
- 5) Click [Select] button
- 6) Note: Show that the programmer is connected

		tion(No Project opened)	
ectic	ChinTune	FEDDOM Chilsum Av03E	FC 0000
W29C020C 🚺	IC Size:	0x40000 Bytes (262144 Byte	as)
Set Interface			
	ICSP_VCC Enable	Vcc current Imax: Default	G S Bits C 16 Bits
Address 0 1 2 3 4 5 6 7 8 9 A	alchelelacen		
100-0000 FF	elect Device		
00-0010 FF	Search Device	Manufactory	Device
00-0020 FF	100240020 C	e e e e e e e e e e e e e e e e e e e	W29C020 BPECC32
00-0030 FF	Type		VESCUEU ETROPEC
00-0040 FF	• ALL		W29CD2DC BTROPS2
000-0050 FF	C ROMFLASHNVRAM		
00-0060 FF	C MCUMPU		
00-0070 FF	← PLD/GAL/CPLD		
00-0080 FF	C SRAM/NVRAM		
00-0090 FF	∩ NAND		
00-0000 FF			
00-0000 FF			
00-00C0 FF			
00-0000 FF			
00-00E0 FF			
00-00F0 FF			
00-0100 FF			
00-0110 FF	Winbond		
00-8120 FF	1000		
00-0130 FF		19.	
00-0140 FF	WINBOND	IC Total: 16666	Select Canad
FLASH Device.Info			June Cara
ptions	IC C	Config Informaton	
Erase before	E	protect after progr	
Verify after Auto SN_N			
Blank Check Addr. K2 ALL Sec			
0000000 ~20005PF			

3.2 Read and Save

After selecting IC in section 3.1 steps

- 1) Click the [Read] button on the toolbar and pop up the Chip Read dialog box.
- 2) In the Chip Read dialog box, click the [Read] button.
- 3) Read finished and then click the **[Back]** button.
- 4) Click [Save] button on the toolbar (you can also select "File-Save" in the main menu), type in the file name to save the file.



3.3 Programing a new chip

After completing the steps in section 3.2

- 1) Click **[Load]** button to bring up the Open File dialog box
- 2) Select the data file to be written (Test.BIN)
- 3) Click [Open], the file load options dialog box pops up

🜆 Xgpro v10.75

File(F) Select IC(S) Project(P) Device(D) Tools(V) Help(H) Language(L)

CHAR SAVE DAUTO TO CHECK DELARK DELARK READ	+ ADD RAM 🛃 PROG.	🗰 ?abour 🗏 _{calou.}	₿_®-r <u>IV</u>		
select IC	IC Inform	ation(No Project	opened)		
140000000	ChipType	EEPROM	ChkSum: 0x03F9 B5A	E	
				×	
Set Interfa					
	o → UserData	~ U	○ 搜索"UserData	a" E	Bits
Genenal Inf 组织 新建文件夹					
Manufactor	名称		修改日期	类型	
ALgorithm Parameter 此电脑	📄 TEST.BIN 🛛 🔼		2021/2/7 14:36	BIN 🗴	
章 3D 对象					
Adapter Inf					
{ ■ 图片					
🔮 文档					
- ↓ 下载					
▶ 音乐					
「「「「」「」「」「」「」「」」「」」「」」「」」「」」「」」」「」」」「」					
👟 Windows (C:)					
Data (D:)					
	<			>	
文件	名(N): TEST.BIN	~	All_Files(*.*)	~	
		3	打开(0)	取消	
			337(0)	ERAF	
FLASHDevice Info		Config Informat	on		
Pin Detect ID Check ID		UTT-protect per	ore		
		, protect and pr			
Skip Blank Addr.Ra® ALL© Sec Blank Check 0√000000 ->0003FF					

4) According to the default settings, click **[OK]**, at this time the file content has been loaded to the computer memory buffer.

File load Options		X
File Format	Load mode Normal	
To Region	From File Start Addr(Hex): 00000 TO Buffer Strat Addr(HEX): 00000	
© Default ○ FLASH	Clear Buffer when loading the file Clear buffer with default	
	OK Cancel	

5) Click **[PROG]** button, the chip programming dialog box pops up.

6) Click [Program] to get started to program the chip. If no error message appears, that means the programming succeeded.

🌆 Xgpro v10.75					
File(F) Select IC(S) Pr	oject(P) Device	(D) Tools(V) Help(H) Language(L)		
🖆 LOAD 🔲 SAVE 🛛 🔊 AUTO 🖤 CHECE	Delase Brenipy (READ) + ADD RAM 🛃	** PROG.) (III) & ABOUT 🖽 CALCI	и. <mark>А-В-</mark> У IV	
Select IC		5	IC Information(No Projec	t opened)	
	W29C020C		ChipType: EEPROM IC Size: 0x40000 B	ChkSum: 0x03F9 B iytes (262144 Bytes)	5AE
Set Interface © ZIF socket	C ICSP port	□ ICSP_VCC Ena	ble Vcc current In	nax: Default 💌	@ 8 Bits C 16 Bits
General Information					^
Manufactor : UINBOND IC Type : U2900200 ALgorithm : Flash 88	Chip	Program APP Versi	on: 10.75		
Parameter : Flash Si Adapter Information	NONE	gram Range 7 FLASH	W29C020C Start Adr: 00000000	End Adr: 0003FFFF	Location in Socket
ZIF40	The Discontinue of the Projection of the Project	Program Netled Peosed AL 55	mingSucceeded	Save Log	
		6 - Pro	gram BACK		ZIF40

Note: If you need to program more chips, replace the new chip and click [Program] button again to begin a new programming.When programming in batch, you can press **[space bar]** instead of mouse click.

4. Programmer Function Details

4.1 Main Menu Summary

Main Menu Summary	
File	Load File, Save, Find, Goto, Buffer operation, Exit
Select IC	Search and Select IC, 25 Flash Detect, Add IC by user
Project	Open Project, Save Project, Save Project As, Close Project, Project Attrib, Modify Password
Device	Read, Read ID, Verify chip, Verify, Program, Erase chip, Blank Check, Serials number, Testing, Multi
	Prog., NAND bad block check, logic IC test, TV/LCD Tools
Tools	Calculator, System self-check, Reflash firmware
Help	Help, About, Update On Line
Language	switch languages, English, Chinese, Russian, Polish, German, Spanish, Portuguese, Turkish, Czech
Right click menu	Find the corresponding hexadecimal value or ASCII character string in the buffer, data, copy, paste, fill in,
Edit buffer	partially save as TXT file

4.2 File Menu

File(F)	Select IC(S)	Project(P)	Device(D)
Loa	ad File(O)		Ctrl+O	_
Sav	ve(S)		Ctri+S	
Co	ру		Ctrl+C	1
Pa	ste		Ctrl+V	
Blo	ock Save As(S)	txt	
De	fine Block		Ctrl+B	
Fill Cle Cle	Block(F) ear current bu ear all buffer(uffer(C) A)		3
Fin	d		Ctrl+F	16
Fin	d Next		F3	16
Go	to(G)		Ctrl+G	16
Evi	+(X)			16

Load file:

Loads a hex file or a binary file into the specified buffer, the GAL chip loads the file in JED format.

Save file:

Save the current buffer to HEX file in hex format or BIN file in binary format. For GAL chips, should be saved to JED format file.

- Note: For MICROCHIP microcontrollers, when loading HEX files, the HEX files generated by the MICROCHIP IDE development environment are loaded into all buffers. When saving, all buffers can be saved to the HEX file, and it is fully compatible with MICROCHIP IDE development environment.
- Save and open for Bin file, the default is Flash Memory + EEPROM Memory (if present)
 For MICROCHIP microcontroller, Bin saved configuration information (arranged by Microchip address)
- Can use shortcut keys or right-click in the buffer to invoke the menu functions.
- To get more details on Edit Function-->Edit Buffer

4.3 Select IC

The menu is shown below:

		-
File(F)	Select IC(S)	Project(P) Devi
📽 10A0 🖡	Search a	and Select IC(S)
Sele	25 Flash	Detect
	Add IC b	y user

4.3.1 Search and select IC

Search Device	Manufactory		Device	
	GREEN-ENGINE		PIC10F200	
	GREENWICH	<u>^</u>	PIC10F202	
	GTN		PIC10F204	
Bran c	HITACHI		PIC1OF206	
Type	HOLTEK		PIC10F220	
	HOPEFIND		PIC10F222	
• ALL	HUAHONG GROUP		PIC12C508	
	HUAJIE		PIC12C508 #SOIC8	
C ROM/FLASH/NVRAM	HYNIX		PIC12C508A	
	HYUNDAT		PIC12C508A REGICS	
○ MCU/MPU	ICE		PIC12C509	
	ICHIC		PIC12C509 RSOIC8	
C PLD/GAL/CPLD	ICT		PIC12C509A	
	TRSENTCON		PIC12C509A REGICE	
🔿 SRAM/NVRAM	INT		PIC12C671	
	INTEGRAL		PIC12C671 BDENS	
🔿 NAND	INTEL		DIC12C671 BEOICS	
	Teer		PIC12C672	
	NHIC .		DICIZCEZZ BOWNS	
	KAIC		DICI2C672 BROICE	
	LITTICE		DICIDCEELO	
	LATITCE		PICI2CESIO DICHOCEEIO BROIZO	
	LINKAGE		PICI2CESIO BOOICO	
	LINKSHRRI		PICI2CESIS	
	1722		PICI2CESIS SOULS	
	LISS		PICI2CE6/3	
	LIONIEK		PICI2CE673 gSOIC8	
	NACRONIX (NAIC)		PICIZCE674	
	NAXCOM		PICIZCE674 ØSUIC8	
	RAINELL		PIC12F1822 WDIP8	
	MICROCHIF memory		PIC12F1822 8SOIC8	
	MICROCHIP MPU		PIC12F508	
<u> </u>	MICRON		PIC12F508 @M50P8	
	NITSUBISHI		PIC12F508 #SOIC8	
	NOSEL VITELIC		PIC12F509	
MICROCHIP	NSHINE		PIC12F509 @M3OF6	
	NY-NS	\sim	PIC12F509 050IC8	
	INTSON		IPIC12F510	

4.3.2 Auto Detect 25 Flash

25 Flash automatic detect, for 8-pin, 16-pin and VGA (T56) HDMI serial 25 series Nor Flash, note: many chip IDs are the same and results have more than one, so you need to select an accurate model in the results.

Auto Search 25 Flash or VGA_HDMI_ISP		×
function description Only for 8/16 Pins or VGA_HDMI_ISP 25series large capacity Flash Memory. after detecting completely, Push < Select > button to automatic selection	Location In Socket	
Pin Counts or VGA_HDMI_ISP		

4.4 Project Menu

The project file is created for better batch programming. It is a file that saves all current buffer data and working environment settings, including information about the current device, settings of all operation options, and settings related to auto serials number. It is convenient to use in daily mass production. The project can be set up with password protection, which can protect the security of the product program to a certain extent. The menu is shown below:

Kgpro v10.75	
File(F) Select IC(S)	Project(P) Device(D) Tools(V)
	Open Project(O) Save Project(B) Save Project As(S)
	Close Project(C)
Set Interface • ZIF socket	Project attrib(A) Modify Password(K)

Save Project

After setting the required parameters of the chip in the application, select **[Project]** - **[Save-Project]**, that is, a project is created. And the project information is displayed in the information area of the window. Click **[Save Project]**, type in the project name and click OK, then the following project dialog box pops up.

Project attribute		<	<
Basic Information			
File PATH:	D:\Xgpro\UserData		
Project Name:	test		
Device Type:	W29C020C		
Project Desc:	test		
CRC 32bits:	0x 7F7445B6		
Create Time:	2021-02-08 15:28 Modi: 2021-02-08 15:28		
Password length<8:	****		
Confirm password:	nije nije nije nije nije nije		
🗌 Prot	ected	Save	

- 1) Password can be empty, that means the current project is not set with password protection.
- 2) If the project is set to protection mode, the password must be input. When the option "Protected" is checked, the relevant data of the project will not be changed. Some functions of the programmer are disabled.

Password	×
Project is Encrypted!	
Input PASS:	
OK Cancel	

Open project

Open a current project, select [Project] - [Open Project], select the project name in the window and click OK. If the project has been set password, the following dialog box will pop up. (If no password is set, the project will be opened directly)

Save project As

Save the current project as another project name. Refer to the operation of [Save Project].

Close Project

Close the current project. Switch to normal programming mode, close project and clear data in the current buffer.

Project Attrib.

Select [Project] - [Project Attrib] to bring up the project attribute dialog box. The project attribute dialog box can change the project description and project protection mode. You need to input the project password when saving.

Project attribute			×
Basic Information			
File PATH:	D:\Xgpro\UserData		
Project Name:	test		
Device Type:	W29C020C		
Project Desc:	test		
CRC 32bits:	0x 7F7445B6		
Create Time:	2021-02-08 15:28 Modi: 2021-02-08 15:28		
🗹 Prote	eeted	Save Cancel	

Modify Password

Reset project password

Modify Password		×
Old Password:	***	
New password:	***	
Confirm password:	** ** ** ** ** **	
	Save Cancel	

Tips:

- 1) Accurate engineering descriptions can distinguish from a large number of projects. Engineering models are generally used for mass production.
- 2) The project file has been encrypted to a certain extent, so the project password can be protected to prevent the project file from being copied. To a certain extent, it can protect the data.
- 3) When saving or opening project files, all contain 32-bit CRC check information, which avoid corrupting storage files or other uncertainties.

4.5 Device Menu

This menu function is the programming operation of the chips, please see section 4.10 Programmer operation function for details The menu is shown below:

Device(D)	Tools(V)	Help(H)	Langu
Read Read II Verify	(R) D(I) (V)		
Progra Erase Blank (m(P) (E) Check(B)		at: ;
Serials	Number		
Testing	3		
Multi P	Prog. Bad Block	c Check	
Logic I TV/LCI	C Test D Tools		

4.6 Tools Menu

The menu is shown below:

Tools(V)	Help(H)	Language(
Calcu	lator(T)	
Syste	m Self-cl	neck :
Refla	sh firmwa	are

4.6.1 Calculator

This is a calculator that comes with Windows system and it is convenient for calculating various formats when switching to scientific mode.

4.6.2 Self-check programmer hardware.

Note: Before self-checking, please remove the IC and ICSP connecting wires on the ZIF socket, the programmer will apply VPP, VCC, GND to all pins for testing in self check. And test the internal short-circuit over current (apply VPP VCC and GND on each pin at the same time). If the IC is on the ZIF socket, may damage the IC. After the test is completed, the test condition of each power supply is displayed in the dialog box.

4.6.3 self-check on TL866II Plus

Programmer Self-Check	\times
Self-Check Test Result	
No.29#OK!	^
No.30#OK!	
N0.31#OK!	
N0.52#	
No.33#OK!	
No 35#OK!	
No.36#OK!	
No.37#OK!	
No.38#OK!	
No.39#OK!	
No.40#OK!	
Test VCC short protection	
VCCshort protection OK	
VPPshort protection OK	
VIIshort protector OK	\sim
Normal	
II-Check Kesuit	
Test	

4.6.4 self-check on T56

Self-dia	ignosis	s																×
PIN	vcc	VPP	GND	10	SHORT	PIN	vcc	VPP	GND	10	SHORT	PIN	vcc	VPP	GND	10	SHO	RT
1	v	v	v	v	v	48	v	v	v	v	v	J1	v	v	v	v 🗌	v	
2	v	v	v	v	v	47	v	v	v	v	v	J2	v	v	v	v 🗌	v	
3	v	v	v	v	v	46	v	v	v	v	v	J3	v	-	v	Y	v	
4	v	v	v	v	v	45	v	v	v	v	v	J4	v	-	v	Y	v	
5	v	v	v	v	v	44	v	v	v	v	v	J5	v	-	v	Y	v	
6	v	v	v	v	v	43	v	v	v	v	v	J6	v	-	v	Y	v	
7	v	v	v	v	v	42	v	v	v	v	v	J7	v	-	v	Y	v	
8	v	v	v	v	v	41	v	v	v	v	v	J8	v	-	v	Y	v	
9	v	v	v	v	v	40	v	v	v	v	v]						
10	v	v	v	v	v	39	v	v	v	۷	v]						
11	v	v	v	v	v	38	v	v	v	v	v]				1	2	3
12	v	v	v	v	v	37	v	v	v	۷	v		การเก	8V-5	5\ 0 .	. 4 93	-	-
13	v	v	v	v	v	36	v	v	v	v	v]	011[4	.04-3.		4.33		
14	v	v	v	v	v	35	v	v	v	v	v	1		10 3		3.29	-	-
15	v	v	v	v	v	34	v	v	v	v	v	1		VUU 3	.3V:	3.30	-	-
16	v	v	v	v	v	33	v	v	v	v	v]		VPP 1	12V:	11.73	-	-
17	v	v	v	v	v	32	v	v	v	v	v	V	CC Im	ax PF	10 T:	v	-	-
18	v	v	v	v	v	31	v	v	v	v	v	V	PP Im	ax PF	10 T:	v	-	-
19	v	v	v	v	v	30	v	v	v	v	v]						
20	v	v	v	v	v	29	v	v	v	v	v]						
21	v	v	v	v	v	28	v	v	v	v	v]						
22	v	v	v	v	v	27	v	v	v	v	v			D				
23	v	v	v	v	v	26	v	v	v	v	v		agnosis	Result:				
24	v	v	v	v	v	25	v	v	v	v	v				N	ormal		
																CHECK		EXIT

4.6.5 **Reflash firmware**

Reflash the firmware of the programmer hardware. The application is upgraded to a new version.

If the program in FLASH needs to be upgraded and reflashed, the application will prompt for a firmware reflash. If no refresh is needed, the reflash function is disabled.



Click <Tools-Reflash firmware> to bring up the following dialog box:

Reflash Firmware	×
Attention: Ple computer reli and closes all upgrade proce failure restart	ease carry on this upgrade operation on the ably, and guaranteed that computer's power supply, other application software. In the hardware ess, If the computer to halt or the system power s that possibly damages the programmer.
APP Version:	V10.75
Hardware Type:	TL866II-Plus
Current Firmware	V04.2.123
C	lick <reflash> to upgrade</reflash>
	Reflash Cancel

Click <Reflash> button to start, the total reflashing time is about 15 seconds. Click <Cancel> to quit reflashing.

Note:

1. Please do not use an external USB hub when reflashing. Please directly connect the programmer to the USB port of your

computer. Using an external hub may not allow the reset upgrade.

2. Close other programs and make sure the power supply of computer is reliable!

4.7 Edit buffer

The programmer software can modify the contents in the buffer, the common functions as below:

- Define Block
- Fill Block
- Copy
- Block Save As
- Clear buffer
- Find
- Find Next
- GOTO address

4.7.1 Define Block

There are two ways to define block:

The first way is: Press the left mouse button in the buffer, move the mouse to select a piece of data and then press the right mouse button, the following menu appears as below:

Address	0	1	2	3	4	5	6	7	8	9	A	В	С	D	Ε	FAS	SCII		
000-0000	ØA	00	00	00	EE	01	00	00	DE	03	60	00	D8	00	00	00			
3000-0010	0F	00	00	00	05	00	00	66	30	00	60	00	22	01	00	00	····· ···		
1000-0020	48	00	00	00	90	03	00	00	09	00	60	00	09	00	00	00 <mark>J</mark> .	• • • • • • • • • • • • • • • •		
3060-0030	84	00	00	90	57	00	00	00	58	00	60	00	00	00	00	00 **	WX		
3060-0048	42	00	00	90	57	00	88	00	58	00	60	00	1 B	00	00	00 ^B .			
3060-0050	57	00	00	99	ØD	00	88	00	0D	00	60	00	84	00	00	00 🖬			
1000-0069	EE	01	00	00	03	00	00	00	6E	00	60	00	14	0		Сору		Ctrl+C	
3000-0070	00	00	00	00	89	00	00	00	00	00	60	00	00	0		Paste	1	Ctrl+V	
9000-0089	01	00	00	99	01	00	00	00	31	38	31	30	30	3		Block	: Save As(S)	txt	
3000-0090	00	FE	F		Defin	e Block	Ctrl+B												
1000-00A0	FE	F		Fill Bl	lock(F)														
3060-0080	FE	F		Clear	current buffe	er(C)													
9060-0906	FE	F		Clear	all buffer(A)														
3000-00D0 :	FE	F		Find		Ctrl+F													
1000-00E0	FE	F		Find	Ne×t	F3													
3000-00F0	FE	F		Goto	(G)	Ctrl+G													
3000-0100	FE	88	00	00	60	00	00	•••••											
3060-0119	00	00	00	00	00	00	00	00	00	00	60	00	00	00	00	00			
3060-0129	00	00	00	00	00	00	00	00	00	00	00	00	00	00	00	00			
3000-0130	00	00	00	90	00	00	00	00	00	00	60	00	00	00	00	00			
3000-0149	00	00	00	90	00	00	00	00	00	00	60	00	00	00	00	00			•

The second way is: in the main menu, click [File] button to select [Define Block], or directly press the shortcut key "CTRL + B" to bring up the following dialog box, type in the start address and end address, and press OK to complete the "Define Block".

Block define			×
Start Addr:	0		
End Addr:	0		
	OK	С	ancel

Subsequent block operations can be done on the defined data blocks.

Copy block, Fill block, Block save as TXT file

4.7.2 Fill block

"Fill block" is to replace all the data of a continuous address in the program code buffer with a fixed value. Right mouse click to bring up [right click menu], and select [Fill Block], the following dialog box pops up:

Fill block ×
Region • FLASH
Stard_Addr: 0x 00000059 Bind_Addr: 0x 0000007F
Value(HEX): FF
Format ⓒ BYTE ○ WORD ○ Tri_byte ○ DWORD ○ Random
OK Cancel

- A. Buffer Region, the default value is the buffer displayed in the current window.
- B. The start address and end address of the block to be filled. The default value is from the start to the end of the defined data block if a block is defined. If no block is defined, it is the full region of the current buffer.
- C. Fill value, the maximum allowed is 4 bytes. If the fill format is random, the value is irrelevant.
- D. Filling format, default format: If the chip is programmed by 8-bit mode, the default is single-byte mode. If the chip is programmed by 16-bit mode, it is double-byte mode, you can change the filling format you want.

4.7.3 Copy

After defining block, right mouse click to bring up [right click menu] and select [Copy], then the content of the block has been copied to the clipboard of WINDOWS. You can also directly press shortcut key "CTRL+C" to finish copying. Copy data from area A to area B as below:

数据地址	Q	1.	2	3	4	5	-6	7	8	9	A	3	C)	D	Ŧ	7	ASCII
000860:	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	
888618:	90	16	64	Eő	8E.	88	74	70	FB	28	48	Dő	89	20	50	8F	
888828:	D7	D8	F5	30	F9	- 81	40	53	51	93	CE	89	8F	0.9	87	7A	
000030:	DA	83	DB	CB	ЗF	86	77	45	28	64	88	83	43	CE	28	68	
000040:	BA	28	23	-51	95	CC	01	89	49	31	61	9C	88	8C	42	有能	.(#QI1aBL
000050:	58	18	60	98	70	12	77	59	85	FF	FF	FF	FF	FF	FF	FF	[p.wV.
000068:	FF	FF	FF	SEE.	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	
888878:	FF	FF	FF	1	YFF	FF	FF	FF	FF	FF	FF	1	YFF	FF	FF	FF	
000080:	FF	FF	FF	10	/FF	FF	FF	FF	FF	FF	FF	2	/FF	FF	FF	FF	**************
000020:	FF	FF	FF	FF	FF	FF	FF	FF	FF	· FF	FF.	FF.	FF	FF	FF	FF	
8888A8:	FF	FF	FF	FF	EF	ØC	16	64	Eó	8E	56	74	70	E8	28	48	t .+H
000088:	D6	A9	20	50	BF	07	D:8	F5	38	FP	A1	ЧD	53	51	93	CE]MSQ
0000000:	89	BF	D9	87	7A	DA	83	DВ	CB.	3 F	86	77	45	28	84	88	Z?.₩E≍
COCODE:	83	43	CE	28	ØB	8A	28	23	51	95	CC	D1	89	49	31	61	.C.*(40I1a
0000650:	90	88	0C	42	40	58	18	D9	98	78	12	77	59	85	FF	FF	BL[p.wY
8086F0:	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	

Note: In order to enhance the speed of pasting, the data format of clipboard is a special binary format for this programmer. So other WINDOW applications cannot directly use the data copied to the clipboard by this program. If you want to copy the data block to other applications, please use the [Block Save As] TXT file function.

Block Save As

You can output the defined data block as a TXT text file, that is convenient for designers to apply when programming. The text format is automatically arranged in 16-bit or 8-bit way. Operation method: After defining block, click the right mouse button to bring up the [right click menu] and select [Save Block As].

4.7.4 Clear Buffer

Clear Current Buffer: clear the buffer displayed in the current window of the application.

Clear all buffers: clear all buffers of the chip with default values.

Find, Find Next

Function: Find the HEX or ASCII string in the current buffer.

Operation: Press shortcut key "CTRL+F" or click the [Find] in the right-click menu, the following dialog box pops up:

Find			×
FI	ND:		Find next
	_Format		Cancel
	• HEX	○ ASCII	

Type in the HEX value or ASCII string you want to find, and finally click the "Find" button in the dialog box. When there is a matching hexadecimal data or string in the program code buffer, the cursor will be located to the address of the first matching content and press F3 to continue finding the next one until the buffer is completely searched.

4.7.5 Goto address

Function: Move the cursor to the address specified in the current buffer.

Operation: Press shortcut key "CTRL+G", or press the right mouse button to bring up the menu and select [Goto], then the following dialog box pops up:

Goto				×
Goto Address 0x:	00 00000000			
•				
· ·		OK	Cancel	

Type in the address, click OK button and the cursor will move to the address.

4.8 Options

Options of programming setting are shown below. You can set the options Use default setting for mass production , don't need to modify.

Ontions		-IC Coofig Information-
 ✓ Pin Detect ✓ Erase before 	☑ Check ID	Orr-protect before protect after progr
 ✓ Verify after ✓ Skip Blank □ Blank Check 	☐ Auto SN_N Addr.Rz ALL Sec 0√000000 ->0003FF	

4.8.1 Pin Detect

Before operating, the software automatically checks if the chip pins are in good contact. It can avoid programming or reading errors caused by poor pin contact in most cases.

Special case of pin poor contact

Because of pin severe oxidation, some individual pins may not be completely disconnected, (for example, it is equivalent to a contact of 3-10K resistance). In this case it is not possible to detect if the contact is good, and errors may occur during programming. So for old chips, the pins should be handled carefully.

For very few chips, the pin detect may fail. You can temporarily uncheck this option "Pin Detect" while ensuring that the pin contact is good. In that case, no pin detection will be performed before reading or writing.

4.8.2 Erase before (programming)

Erase the entire contents of the chip before programming

Some chips do not have erase function, this option will be disabled, for example: most 27Cxxx chips are one time OTP ROM or UVROM. These chips are not erasable or do not have the electrical erase function.

For 24 series, 25 series, EEPROM 93 series chips, this function is also disabled when there is no special erase command. That means these chips do not need to be erased and can be rewritten directly. (If you must erase the data of the chip, you can write 0xFF into the entire memory of the chip)

4.8.3 Verify after (programming)

4.8.4 Skip Blank

The write operation will be skipped for FF data blocks, that can greatly improve the programming efficiency. When this option is checked, the verify operation will also be skipped.

4.8.5 Check ID

Many chips have an internal identification mark, the content of which is generally composed of two or more bytes: generally, the first byte is the Manufacture ID, followed by the chip type or chip capacity. Different chips have different IDs, this option can prevent incorrect chips put on. This option is to check the chip ID before reading or writing. If it is correct, continue; if incorrect, stop. This function is optional. The option is enabled by default.

For chips of the same type, they have different manufacturers, but may be programmed in the same way. Therefore, for chips that are not in the support list, you can select other manufacturers of similar model chips with the same capacity for programming. Because the ID is different, before programming, just uncheck this option [Check ID]).

4.8.6 Address range

You can set the address range of the programming chip, that can improve the efficiency when mass production.

4.8.7 Blank Check (before programming)

Except for the 27 series UVROM, generally it is not necessary to check this option.

4.8.8 Auto SN_N

Refer to section 4.10.7 Setting the Serials number

4.9 Select IC

Click <Select IC> button in the upper left corner of the software interface

ect IC	IC Information(No Project opened)
ATMEGA16A @DIP40	ChipType: MCU/MPU ChkSum: 0x0041 BE00
ect Device cli Search Device ATMEGAI6A Type • ALL • ROM/FLASH/N/RAM • MCU/MPU • PLD/GAL/CPLD • SRAM/N/RAM • NAND • EMMC/EMCP • VGA/HDMI • enter IC m	IC Size: DX4000 Bytes (10384 Bytes) + 0x200 Bytes ck select IC button Device ATMEGAI6A @DIP40 ATMEGAI6A @DIP40 ATMEGAI64 @DIP40 ATMEGAI64A @DIP40 ATMEGAI64A @DIP40 ATMEGAI64A @DIP40 ATMEGAI64A @DIP40 ATMEGAI64PA @DIP40 ATMEGAI64PA @DIP40 ATMEGAI65PA @DIP44 ATMEGAI65PA @DIP44 ATMEGAI65PA @DIP46 ATMEGAI65PA @DIP64 ATMEGAI68A @DIP28 ATMEGAI68A @DIP28 ATMEGAI68PA @TOFP32 ATMEGAI69PA @TOFP64 ATMEGAI69PA @TOFP64
Atmel Corporation IC Total:	26022

When selecting, the package of chip must be right. Sometimes, different packages of chips have different pin definitions. For the same type of IC, (none Package is DIP package chips.)

if the specific package is not listed, just check the IC data sheet and directly connect the corresponding pins to program.

4.10 Programmer operation function

4.10.1 Read

Read means reading out the data from the chip into the buffer. The reading window may be different from different models of chips. for example, the chip ATMEGA16L, click [Read] button in the toolbar and the following dialog box pops up:



First of all, set the [Read Range], which includes [FLASH] [EEPROM] [Config.] [LOCK Bit]. do reading operation on the entire chip. Click [Read] button to start reading the data of chip, note: if the chip is encrypted, the read data is invalid.

(for ATMEGA, [LOCK Bit bytes] in config, the datas are readable whether be encrypted or not.) After reading, the reading time of the individual buffers is displayed in the information list box.

Note: generally, the read operation will not report an error. If you want to verify whether the read data is correct, you can use the [Verify] function. Please see the verification instruction for more details. The chip ID value will be checked by default before operation.

4.10.2 Program

Load the data file to program chip

Click **[PROG.]** button in the toolbar, the chip program dialog box pops up as below:

Take W29C020 as an example,

Normal programming is shown below:

Chip Program	APP Version: 10.75				
Program Range	Start Adr:	00000000	End Adr:	0003FFFF	Location in Socket
Pins Detected Passed D: 0x 0A 45CKI EraseSucceeded. Time : (Protection Disable0KI Provermine FLASHSucc	ProgrammingSucc	eeded		Save Log	
Verifing FLASH Succeeded Programming Succeeded	d Time: 47ms				7/640
	Program	BACK			21640

- For most of the chips, the programmer will automatically verify during the programming process. Will stop immediately if an error is found.
- If the option [Auto SN_N] is checked, the chip number in the buffer will be automatically incremented according to the setting after programming.
- To ensure the correctness of programming data, it is advisable to check the option [Verify after].
- •

4.10.3 Erase

For the electrically erasable chip, click [Erase] button in the toolbar to bring up the following dialog box:

Chip Erase APP Version: 10.75	
DEL: W29C020	Location in Socket
EraseSucceeded	Save Log
	ZIF40
Erase BACK	

The option [Check ID] is checked by default. For few parts of microcontrollers, some chips while it be encrypted and the ID cannot be read out. In that case, please uncheck the option [Check ID], otherwise ID Error will be displayed. Click [Erase] button in the dialog box, after the erase succeeded, the erasing time is displayed.

4.10.4 Blank Check

Click [Check Blank] button in the dialog box to start the check blank operation. When it is finished, the elapsed time is displayed. You can select the region of the chip before checking, all region is by default. If the chip is found to be non-empty during the blank check, will stop operation and the address and stored value of the non-empty area will be displayed.

4.10.5 Verify

You can select the region of the chip before verifying, all region is by default. Click [Verify] button in the dialog box to start the operation. If all the data are the same, the elapsed time is displayed when verify finished.

If the chip datas are found to be different during verifying, the following dialog box will pop up:



Click [Continue]: The same dialog box will pop up again if there are still differences.

Click [Verify to all]: It will compare all the contents of the chip, and prompt will pop up if differences are found during the comparison process, until it is finished. It will prompt how many differences and show the different cells in red font in the buffer (except NAND), as shown below:

Click [BACK]: It will exit directly without the later verifying.

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	Address	0	1	2	3	4	5	6	7	8	9	А	В	С	D	Е	ASCII										•
ſ	9000-0000	FF	• • • • • • • • • • •	• • • • • •									1 Programmer Connected.														
	000-0010	FF	nin Verify	APP	Versio	n: 10.75							Derrice 1: TLOCALE Dive News														
l	000-0020	FF	iip veriiy	~ ' '	101310						-																
	9000-0030	FF	Verify Range				W2	9C022					Location in Socket														
l	000-0040	FF	✓ FLASH	I		Start A	Adr:			End Adr:	 																
	000-0050	FF																									
l	000-0060	FF																									
	000-0070	FF																									
	000-0080	FF		Ve	erify Res	ult(differen	cequan	tity): 20)		Save Lo	<u>g</u>															
	9000-0090	FF	Pins Detected Passed	1								_															
	000-00A0	FF	D: D:: DA 45OK) Verifing FLASHSue	ceeded. Tim	ie : 4578ms																						
	000-0080	FF																									
l	000-0000	FF																									
l	000-0000	FF																									
	9000-00E0	FF																									
l	000-00F0	FF																									
	000-0100	FF											ZIF40														
	9000-0110	FF																									
	000-0120	FF																									
	000-0130	FF				Verify		BAC	к																		

4.10.6 IC Config.

Click [Config.] button, the interface is as below (select IC model: PIC18F4555):

	Two and In three and A	ann 🖻 ann 🕮	
elect IC	IC Information(N	vo Project opened)	
PIC18F4455 @DIP40	ChipType: MC	3U/MPU ChkSum: 0x0060 9F00 0x6000 Bytes (24576 Bytes) + 0x100 Byte	s.
et Interface		Default T C P C	C 16 D
· ZIF SOCKEL C ICOP port	LI ICSP_VCC Enable Vcc c	ument Imax: 1	s v 10 Dids
300001 100 / ICE / ICEN / ISEAC (ICE / ICEN / IC	0011 M 10012 M 11112 M		A Device of Control of

The value of the config information in the red circle corresponds to the config interface: click on the config interface, the value in the config information will change automatically. The config information varies from chip to chip, so please check the chip's data sheet at first, and configure IC correctly according to your specific needs.IC config, need to understand the role of each bit in the configuration bits

4.10.7 Serials number

The chip number setting function is to automatically add a number to a certain memory area of the chip during programming, that can easily program the chip at the factory. You can add time or unique serial numbers and so on, also can use a variety of numbering algorithms. Click <Device>---<Serials Number> in main menu to bring up the following dialog box:

Set Auto Serials	×
AutoInc. mode • Default INC. • Time Mode • Radom • User Define	Operations 00000000 SN Length: 08 original value: 18100073 Inc. Step(10): 1 CODE Inc. Format Image: HEX Code DEC Inc. from high address
Region FLASH C DATA C USER.ROW C USERID	Record: Note: Save Serials to end of this file
M	Enable Auto.SN Test Save Cancel

Firstly, select the automatic numbering algorithm, there are four modes in the dialog box. And then introduce the every mode separately as below:

4.10.7.1 Default INC. (Default Incremental Algorithm)

The setting interface of this algorithm is shown above. The function of this algorithm is to put a number of set length at the place where the set storage area of the start address, and the number increases according to step length at a time. After setting the parameters, you can click <Test> button to test and see the change rule under various parameter settings.

The initial value and step length of the number can be set in the dialog box.

After setting the parameters and testing them well, set the record file. If it is empty, the record file is invalid and the data will not be recorded into the file when programming. If the record file is set, the number you set will be added to the end of the record file after each programming.

Finally, check the option <Enable Auto.SN> and click<Save> button.

4.10.7.2 Time Mode (algorithm)

The interface of the Time Mode dialog box is as below: at 0x2000, a time data is put in

Autoinc. mode	Operations 2000	
C Default INC.	original value:	
Time Mode	Inc.Step(10)	
C Radom		
O User Define	YYYY-MM-DD 00:00+8 bytes INC.	
Desien		
- Keälon		
\odot FLASH		
🔿 data		
O USER.ROW	Record:	-

There are four types of time encoding formats, which are as below:

- (1) Date + time Total length of number: 16bytes
 - The date and time are added at the specified location during programming, the total length is 16bytes.
- (2) Date + 5 bytes increment Total length of number: 16 bytes
- The increment part can set the initial value and step length.
- (3) Date + time + 8 bytes increment Total number length: 24 bytes

The increment part can set the initial value and step length.

(4) Date + time + 16 bytes of random numbering Total length of numbering: 32 bytes

16 bytes are randomly generated bytes, which can generate a unique serial number of product. In this way, the record file must be set so that the generated code is recorded in the file. Otherwise, you don't know what the product number is. The next steps are the same as above <Default Incremental Algorithm>

4.10.7.3 Random (Random number algorithm)

The algorithm generates a random number of the specified length, as below: 16 bytes of random data are placed at the start address 0x2000

Set Auto Serials	×
AutoInc. mode C Default INC. C Time Mode Radom C Horr Define	Operations Start Addr:0x 00002000 SN Length: 16 CODE © HEX © ASCII
Region FLASH C DATA C USER.ROW C USERID	Record:
	Note: Save Senals to end of this file Image: Enable Auto.SN Test Save Cancel

4.10.7.4 User Define algorithm

The user-defined algorithm is very flexible, you can set any numbering algorithm, see the catalog for details about how to use it. \\Serialnumber\source_dll in the VC++ source program for detailed instruction. The interface is as below:

Set Auto Serials		×
AutoInc. mode C Default INC. C Time Mode C Badom	Operations User algorithm SetSerial_Test 18F4550.4II Note:Copy the file to WERIALNUMBER Algorithm Description [DEVICE] Xingong TL866II DLL Test [Description]	
User Define	PIC18F4550自定义序列号测试 2018-01-11 original value: 18100073	
C FLASH C DATA		
O USER.ROW	Record: Note: Save Serials to end of this file	
V	Enable Auto.SN Test Save Canc	el

The RC correction byte encryption method for AVR microcontrollers is implemented entirely by calling the DLL dynamic library here. ... \\TAMEGA_LED directory contains all the source programs and test methods. After making the DLL file, you just need to copy it to the application directory of ... \\Serialnumber subdirectory. When setting, choose the algorithm file you made in the user algorithm file list. The following steps are the same as the other algorithms. Important Notes:

1) After setting the above content, the programmer will not automatically add the number you set to the chip when programming. If need to automatically add the number, you must check the option [Auto SN_N] in the main interface.

2) In the main interface, the condition that you can check the option [Auto SN_N] is that you must firstly set the numbering algorithm and check the option [Enable Auto.SN] in the set auto serials dialog box.

3) After checking the option [Auto SN_N] in the main interface, if you reset the numbering algorithm, the option [Auto SN_N] must be re-checked in the main interface.

4) If IC model is changed, you must reset the numbering algorithm.

5) In the engineering mode, the algorithm is saved in the project file. You can directly open the project file and automatically transfer to the automatic numbering algorithm. Therefore, it is generally used in the project mode for mass production, it is simple and convenient.

4.11 ICSP Programming

For chips that can be in-circuit programmed serially, the programmer can program the chips on the target board through the unique ICSP interface. Before programming, check the option [ICSP port] in the main interface, at this time the option [ICSP_VCC_Enable] becomes available. The option [ICSP_VCC_Enable] is checked by default, that means the programmer provides VCC power to the target board. Please note: a maximum current that VCC power supply of programmer can provide is 120ma. If the target board needs a larger power supply, please use the power supply from target board itself.

If you do not need power supply from programmer, you can uncheck the option [ICSP_VCC_Enable]. In this case, there will be no VCC power on VCC pins when programming. It is shown as below:

(Ie(F) Select IC(S) Project(P) Device(D) Tools(V) Help(H) Language(L)
🛎 uu 🖬 an (D _{ant} 10 ₀₀₀₁₁ 10 ₀₀₀₁₁ 10000) 🕂 da 🛞 🔐 🕼 🕬 🔛 🤋 dan 🗒 🔤
Select IC Information(No Project opened)
W25Q32BV ChipType: EEPROM ChkSum: 0x3FC0 0000 IC Size: 0x400000 Bytes (4194304 Bytes)
-Set Interface ○ ZIF socket
Address 0 1 2 3 4 5 6 7 8 9 A B C D E F ASCII
3000-0000: FF
3000-0010; FF F Chip Read APP Version: 10.75
3900-0020: FF F Read Range W25Q32BV Location in Socket
3000-0030: FF F 🔽 FLASH Start Adr: End Adr:
3800-0040: FF F STATUS REG
3000-0050 : FF F
3900-0060: FF F
3800-0070: FF F
3800-0680: FF F Connect <icsp> to target board, Click<read>-Button Save Log 3 GND</read></icsp>
1900-0930 ; FF F Matt Correct a 190 Copactor letives in MSD and Cottl Cos VCC 1 //CS
3900-00A0 : FF F Connect a 30P Capacitor @Pin MISO
3000-0080 : FF F
3900-80C0: FF F
3800-0000 : FF F
3000-00E0: FF F
3000-00F0: FF F
3900-0100; FF F
3900-0110; FF F
3900-0120: FF F View ICSP Connection Read. BACK
3000-0130. FF
3000-0140; FF

Next, Read, Erase, Verify, and Program operations will work through the ICSP port. For TL866II, please don't put the chip on the 40PIN universal ZIF socket during operation. The universal ZIF socket of T56 is independent of the ISP port.

Click [Read] button in the toolbar, the following dialog box pops up as below (Please note: the dialog box for read, erase, verify and other operations is the same as write operation):

On the right side, the ICSP port wiring schematic is displayed. For more details, you can click [View ICSP Connection] button.



ICSP supports the following chips:

1) 24 series 25 series 93 series

2) ATMEL89S51, 52, AVR ATMEGA full series, Note: In parallel for high-voltage programming, ISP for low-voltage

programming

3) MICROCHIP PIC10Fxxx 12Fxxx 16Fxxx 18Fxxx full series.

- 4) SYNCMOS SM59Dxx SM59Rxx full series
- 5) SPI NAND, EMMC, VGA_HDMI

4.12 Multi Programming

The software support simultaneously working with 4 Programmers on each computer. For USB expansion, please use a highquality USB hub with power supply. Multi programming interface is as below. The automatic numbering function can be used normally when multi programming.

Multi Programming	×
Multi.Prog. Please use HUB v Programming Option FLASH STATUS REG.	with Power 0
IC: W25Q32BV Interface: ICSP	
Device 1 TL866II-Plus	Device 3
Device 2	Device 4
Prog. [Z]	Prog.[C] Prog.[V]

You can use the shortcut keys [Z] [X] [C] [V] to start the corresponding programmer when multi programming.

4.13 RAM Testing

After selecting the corresponding model of RAM chip, click [Device] - [Testing] button in the toolbar, the following dialog box pops up. TL866II supports, T56 do not support RAM testing temporarily, waiting for the later update.

Chip Test APP	Version: 10.75	
Test Range FLASH Data Bus Address Bu	61512 Start Adr: End Adr: ☐ Increase s ☑ Unit	Location in Socket
	Plug IC into ZIF socket,Click- <test>-Button</test>	TIF40

There are four methods of RAM testing. Through these four methods, you can basically test whether the RAM cell function is normal. General programmer can only read and write the RAM cell and cannot test whether the RAM is good or bad.

For example, if two adjacent address lines are short-circuited, it is impossible to check out the problem by simply reading and writing data from the RAM cell. So only one way to test is not a complete test. Plug chip and click [Testing] button to test RAM.

5. EMMC/EMCP programming

Only T56 can support EMMC EMCP, TL866II cannot support this function.

eMMC (Embedded Multi Media Card) is a standard specification for embedded memory developed by the MMC Association, primarily for products such as cell phones or tablet computers. By integrating a controller into the package, providing a standard interface and managing flash memory, eMMC allows handset manufacturers to focus on other parts of product development and shorten the time to market.

EMCP is a higher-level memory device than EMMC, which combines EMMC and LPDDR into one package, reducing the volume and design for circuit connection.

EMMC/EMCP are available in various BGA packages, general: BGA153/BGA169/BGA162/BGA221/BGA100/BGA254/BGA529 T56 programmer can support them all well.

5.1 EMMC Memory

EMMC flash memory can have up to 8 storage areas, named as BOOT1/BOOT2/RPMB/GPP1/GPP2/GPP3/GPP4/USER. Among them, GPP1-4 are user-defined partitions, which are not configured at the factory.

- BOOT1/BOOT2 is generally used as system boot area and boot data backup partition
- RPMB is a special storage partition, data can be read always, but writing requires a 32-byte authentication key. It must be written through a complex HMAC_SHA256 authentication algorithm, in order to prevent hacking software from illegally modifying the data.
- GPP1-4 are user-definable hardware partitions, which are used in the same way as the USER partition
- USER partition, the largest user data partition
- Partition write protection, GPP1-4 and USER partitions can be written protection in groups, and the write protection modes are temporary write protection, permanent write protection, and power-on write protection. After setting permanent write protection, the protected WPG group can't be erased or modified data permanently.
- EMMC password protection function, if the password is set, the password must be unlocked before accessing the USER

area, otherwise it cannot access.

- ECSD and CSD are configuration registers. The various configurable parameters of EMMC are set in [Device config]. Great part of the registers in ECSD and CSD are read-only registers.
- CID is identification mark of the chip at the factory, which can only be read and cannot be modified.

5.2 EMMC function supported by T56

5.2.1 Analysis of the original chip

This function allows you to get a full overview of the original chip and do operations the way you want. The content of the original chip is analyzed and the following results are displayed:

- Display chip manufacturer information and life cycle
- Visually display the usage of up to 8 partitions of the chip
- Each partition Displays whether it is write-protected, readable, rewritable or erasable
- Displays whether the whole chip is temporarily write protected or permanently write protected
- Display whether the chip is password protected or not
- Display whether the chip uses 32-bit authentication key written to the RPMB.
- Display other important parameters of ECSD CSD CID

5.2.2 Read/Program function

All functions can be done with one key

- Read CID/CSD/ECSD.
- Clear temporary write protection before programming
- Clear temporary write protection group before programming
- Erase chip before programming
- Blank check before programming
- Program 32-bit authentication key
- Check the chip password
- New partitioning of the chip (partition Config)
- Read and write to BOOT1
- Read and write to BOOT2
- Read and write to RPMB
- Read and write to GPP1
- Read and write to GPP2
- Read and write to GPP3
- Read and write to GPP4
- Read and write on user data (User)
- Setting temporary write protection group
- Setting permanent write protection group
- Setting chip password (or reset password)
- Program ECSD
- Program CSD
- Automatic verification of all the above operations after programming

5.2.3 ISP in-circuit programming

• Ultra-stable ISP in-circuit programming with line length up to 40CM, working frequency 40MHZ, reliable work

- ISP can also use 4-bit wide mode, operation speed increased to 4X faster
- See details on Section 5.9 ISP in-circuit programming example.

5.2.4 EMMC ONE-KEY-GHOST

When reading EMMC, the one-key-ghost project can be automatically generated to realize the one-key copying of the original chip content to the new chip. See details on section 5.8 one-key-ghost example.

5.2.5 Other EMMC Functions

- The working frequency and working voltage of EMMC can be adjusted manually.
- Data in the user area can be read and written in blocks and multiple files
- If there is a password protection when deleting, perform forced erase
- Password can use ordinary password or SHA1 encrypted password
- The value of ECSD/CSD can be imported from the ECSD_CSD file or manually set by the user
- Data CRC error can be ignored during read operation
- Optional automatic verification after the reading operation is completed.
- There are high-definition pin diagrams and ISP wiring diagrams in the device information. The pin check and locate the BGA pin.
- EMMC has real-time accurate rate display during read and write operations, and the final total time

5.3 EMMC select IC

5.3.1 The usual method to select IC

Type in IC model (for example, MTFC4GMVEA-1M), as shown below (better to select by this method, AUTO may be not work normally on few of chips):

Select Device		
Search Device MTFC4GMVEA-1M Type © ALL C ROM/FLASH/NVRAM C MCU/MPU C PLD/GAL/CPLD C SRAM/NVRAM C NAND C EMMC/EMCP C VGA/HDMI C VGA/HDMI	Manufactory	Device TTYC400724-18_0024 1004850 TTYC400724-18_1818 8054130 TTYC400724-18_1359_8141 TTYC400724-18_1359_814 TTYC400724-18_1359_814
Micron Technology, Inc	IC Total: 26022	Select Cancel

In general, there are 5 options for the same model EMMC:

- 8bit means 8 bits of data bus width is used when programming, and works at the fastest speed.
- 4bit means 4 bits of data bus width is used when programming, it is available when chip pin D7:4 is damaged.
- 1bit means 1 bit data bus width is used when programming, and can be used when chip pin D7:1 is damaged, and is the slowest.
- ISP_4Bit: 4 bits of data bus width is used when programming through ISP. At this time, the programming speed is also faster through ISP.

• ISP_1Bit: 1bit of data bus width is used when programming through ISP.

5.3.2 Select AUTO_EMMC

When IC model cannot be found in the list, you can type in "AUTO EMMC" to select the corresponding package as below:

search Device	Manufactory	Device
AUTO EMMC	1010	AFTO EBS(157) 11 97 (ceconwend) AFTO EBS(157) 1.3 17 AFTO EBS(157) 94 187 AFTO EBS(157) 94 187 AFTO EBS(253) 91 197 AFTO EBS(253) 91 197 AFTO EBS(253) 37 98 (SGALOO) AFTO EBS(253) 37 98 (SGALOO)
ALL ROWFLASHINVRAM MCUAPU PLD/GAL/CPLD SRAM/NVRAM NAND END/CENCE		AFTO BRD: 48 1.84 (BCALDO AFTO BRD: 48 1.84 (BCALDO AFTO BRD: 18 1.94 (BCALDO AFTO BRD: 19 1.94 (BCALDO
EMMC/EMCP		Arto Entro [-58].40 @ 80.142 Arto Entro [-50].10.00 @ 90.142 Arto Entro [-50].20.00 @ 90.121 Arto Entro [-50].20.00 @ 90.121 Arto Entro [-50].20.00 @ 90.121
XGecu ®		AUTO EDDS_10_1.49 (BGA221 AUTO EDDS_18_3.39 (BGA221
utomatic Identification	IC Total: 2	6022 Select Cancel

- If you program with adapter, select IC of the corresponding package, such as BGA153:
- There are 6 options under BGA153, usually choose the first 8B_1.8V, which represents 8-bit of data bus width is used, IO voltage is 1.8V.
- If you in-circuit program via ISP, usually choose ISP_1B_1.8V (in general, the motherboard IO voltage is 1.8V). If the motherboard IO voltage is 3.3V, choose ISP_1B_3.3V.
- If choose 1.8V, cannot be programmed normally on motherboard, you can try to change to 3.3V for testing.

5.4 EMMC Operation Options

5.4.1 Programmer Operation Options

2.	Operation Options
	Read all and Save to ONE_KEY_GHOST project
	Verify After Programming or Read.
	Select Clock 36 MHZ -
	Select Power voltage VCC=3.3V/VCCQ=1.8V 🔹
	Fine adjust voltage VCC + 0.0V - VIO + 0.0V -
	Ignore data bus CRC errors when reading
	Skip of blank data when programming

Read all areas and save one-key-ghost project

while reading, automatically analyze the chip, read all the data. This option will ignore the next (read, program, erase) option in the part of the selection, will automatically select according to the chip content. After reading, in the data folder a project file EMMC_GHOST.MPJ will be automatically generated. If the user wants to clone a chip, just open this ghost project file and directly program it to the new chip.

• Automatically verify after programming or read

after reading or programming, the data will be automatically verified once.

EMMC Select Clock

Select the clock frequency, 36MHZ is default, you can select 40MHZ or 50MHZ while mass production. If the reading of data is unstable, you can also reduce the clock frequency for testing. Maximum 40MHZ via ISP.

EMMC select Power voltage

Select the IC power voltage, a great part of the chip works at VCC=3.3V/VCCQ=1.8V, with extremely high stability.

- EMMC fine adjust voltage
 If the reading is unstable, can fine-tuning the voltage. It is possible to get a better stable effect. Users can do various tastings of voltage fine-tuning.
- Ignore data bus CRC errors when reading

CRC verify error will be ignored when reading, this option is not recommended.

 Skip of blank data when programming during the verifying or programming, the blank data is skipped in order to increase the programming speed.

5.4.2 Read, Program, Erase options



Select the chip area to read or programmiing. If an item is not selected, no operation will be performed for this item.

The key option RPMB: when programming RPMB, the option [RPMB Authentication Key Operation] must be checked and the correct 32 bytes authentication key must be loaded in the file menu before programming. After the authentication key is written, the chip will use this authentication key permanently and cannot be rewritten with a new authentication key.

5.4.3 Erase, Blank Check option



The erase and blank check operations performed before programming, generally do not need to be changed, just use the default settings. If the chip is new while mass production, the erase can also be unchecked.

5.4.4 File path and file name settings

File Directory	:		Select Directory
D:\Xgpro_T56\UserData\EM	MC_Data		
ECSD+CSD File :	ECSD CSD.BIN		- Analysys ECSI
BOOT1 File :	BOOT1.BIN		
BOOT2 File :	BOOTZ.BIN		
RPMB File :	RPMB.BIN		
GPP1 File :	GPP1.BIN		
GPP2 File :	GPPZ.BIN		
GPP3 File :	GPP3.BIN		
GPP4 File :	GPP4.BIN		
	-		, <u> </u>
User Area :	() Single File	Mode ,All User Area	ÿ
	O Multiple Pa	rtition(Address alig	med by 64K)
Single User Aear File :	UserData.BIN		
Start Address	End Address	File Name	Partition Size
<1> 00 0000 0000	OO OO1F FFFF	UserFart_1.BIN	2048 KB
<2> 00 0020 0000	00 002F FFFF	UserPart_2.BIN	1D24 KB
<3> 00 0100 0000	OO 04FF FFFF	UserFart_3.BIN	65536 KB
<4> 00 0000 0000	00 0000 0000	UserFart_4.BIN	O KB
<5> 00 0000 0000	00 0000 0000	UserPart_5.BIN	O KB
<6> 00 0000 0000	00 0000 0000	UserPart_6.BIN	U KB
<7> 00 0000 0000	00 0000 0000	UserFart_7.BIN	O KB
<8> 00 0000 0000	00 0000 0000	UserPart_8.BIN	O KB
<9> 00 0000 0000	00 0000 0000	UserPart_9.BIN	U KB
<10 00 0000 0000	00 0000 0000	UserFart_10.BIN	O KB
<11 00 0000 0000	00 0000 0000	UserPart_11.BIN	O KB
	-		

Select the data folder

set a new folder before reading or programming, the folder name should preferably be device name + IC model for future use, all the data read will be stored under this folder. Including the automatically generated one-key-ghost project files. Of course, the folder name can be changed after reading. When programming, just select the data folder and make sure that all the data files be located under this folder.

- File name, read generally do not need to change the file name.
 If new product development, mass production, select the data file of the corresponding area.
 Note: All files must be set in the same folder.
- Analyze ECSD button

Check out the information related to ECSD file under the folder.

- If the development of production
 - ECSD file may not exist and user can set the relevant configuration in [Device Config].
- Blocks mode

it can be sliced up to 16 blocks, block address must be 64K aligned, 1K=1024 bytes

Users can write or read the USER Area in blocks, which is convenient for flexible applications when programming in bulk. The blocks mode also has a special function: if the unstable chip has nearly reached the end of its useful life and you want to read the data inside, you can read in blocks. After reading of the all data in the good blocks is completed at one time, then the bad blocks can be read separately for several times (while reading, disable the option "Read all and Save to ONE_KEY-GHOST project").

5.5 EMMC Device Configuration

5.5.1 EMMC Password Setting

[1. Password Set	
	Password In the Device (ASCII) :	
	New Password (ASCII, Reset Password when Blank) :	
	Use SHA-1 Secure Hash Algorithm	

EMMC can use password protection, that only protects the USER Area, BOOTx/GPPx/RPMB partition, cannot be protected by password.

T56 can set normal password and SHA1 password, please refer to EMMC standard document for details.

5.5.2 ECSD Setting

C2. Extended CSD
 CD

[ECSD CSD values are loaded from the file when programming] button

When checked, all fields of ECSD and CSD are loaded from the file and the set values in the interface are invalid. set fields by user while unchecked.

Extended CSD	D_CSD又什執人(木达时用户
PARTITION_SETTING_COMPLETED[155]	00
(<otp> bitsD is valid , bit7:1 Reserved)</otp>	
WR_REL_SET[167]	1F
(<otp> bits4:0 is valid , bit7:5: Reserved)</otp>	
GP_SIZE_MULT_GP1[145-143]	000000
(<otp> defines GPP1 size)</otp>	
GP_SIZE_MULT_GP2[148-146]	000000
(<otp> defines GPP2 size)</otp>	
GP_SIZE_MULT_GP3[151-149]	000000
(<otp> defines GPP3 size)</otp>	
GP_SIZE_MULT_GP4[154-152]	000000
(<otp> defines GPP4 size)</otp>	
ENH_SIZE_MULT[142-140]	000000
(<otp> defines Enhanced User Data Area Size)</otp>	
ENH_START_ADDR[139-136]	0000000
(<otp> defines Enhanced User Data Start Address)</otp>	
PARTITIONS_ATTRIBUTE[156]	00
(<otp> bits4:0 is valid ,sets enhanced attribute in GPPx)</otp>	
EXT_PARTITIONS_ATTRIBUTE[53-52]	0000
(<otp> sets extended attribute in GPPx)</otp>	,
USE_NATIVE_SECTOR[62]	00
(<otp> Valuse is 0x00 or 0x01 , 0x02-0xFF: Reserved)</otp>	
PRODUCT_STATE_AWARENESS_ENABLEMENT[17]	01
(Bit5:4 can be set, bits1:0 is read only, others Reserved)	
PRE LOADING DATA SIZE[25-22]	0000000
(0x0000000-0xFFFFFFF, value reset after a power cycle)	
PRODUCTION_STATE_AWARENESS[133]	00
(the host reports to the device its production state)	
PARTITION CONFIGITIN	00
(This register defines the configuration for partitions)	
BOOT CONFIG PROTI1781	
(<otp> This register defines hoot configuration protection)</otp>	00
BOOT BUS CONDITIONS/1771	
(This register defines the hus width for hoot operation)	00
BOOT WPI1731	00
(<otp> Boot area write protection register)</otp>	I 00
USER WPI1711	00
(<otp> User area write protection register)</otp>	I 00
FW CONFIGNER	
(<otp> Bit[0]: Undate, Disable Bit[7:1]: Reserved)</otp>	I
BKODS ENITESI	
(<otp> Bit(D) = 1 ENABLE Bit(7:1): Received)</otp>	L 00
RST & FUNCTION/1621	00
(<ctp> Bit[1:0]: valid Bit[7:2]: Received)</ctp>	L UU
(SOT > DRITED, VARIO DRITEZ, RESERVED)	00
асс_еже_еки, momni (134) («ОТВ» Bad Black Management mode, hit7:1 Becomed)	L UU
(SOTE > Dad Diock Management mode, bit/. I Reserved)	
PERIODIG_WAREUP[131]	
(Henouic wake-up timer)	
SECURE REMOVAL TYDEMEL	L 01
- All ECSD register fields options, only when checked, the chip will be programmed and verified. Unchecked registers will not be programmed and verified.
- The first major option [PARTITION SETTING COMPELTED 155], when checked, the value must be 01, and it's subparts must be all checked, and the subparts must meet the EMMC standard, otherwise they cannot be written. This major option is to set the EMMC partition and partition attributes, the chip is not allowed to repeatedly set the partition size and attributes.
- All registers marked with OTP are written at once, so please set them carefully
- When [USE_NATIVE_SECTOR 62] button is checked, the value must be 01, otherwise it is the error.
- All other registers can be checked, or only the non-00 registers be checked
- Note: The above options will be checked automatically when the original chip is read with the one- key-ghost project is generated automatically.

5.5.3 CSD Setting

-3. CSD		
	FILE_FORMAT_GRP <otp> :</otp>	0 = as FILE_FORMAT
	FILE_FORMAT <otp> :</otp>	00 = Hard disk-like file system 👻
	COPY <otp> :</otp>	0 = Original 👻
	PERM_WRITE_PROTECT <otp> :</otp>	0 = Disable 🔍
	TMP_WRITE_PROTECT :	0 = Disable 🔍
	ECC:	00 = Default 👻

- If any option in CSD is non-zero, check the option [CSD programming] in EMMC Operation Options (2.Reading/ Erasing/ Programming Options)
- When auto-generating one-key-ghost project, the software will check the all ECSD/CSD options automatically.

5.5.4 Write Protect Groups (WPG)

-4. Write Protect Groups Set (WPG)		
ERASE_CROUP_DEF[176] : (0: Use old erase group	a size and WPG size (default) EraseUnitSize/EraseTimeout/WPG size	
Temporary Protected Group(s) (e.g. D, 5, 7-9,) : 		GPP1 GPP2 GPP3 GPP4 USER
Permanent Protected Group(s) (e.g. 1, 3, 11-20,) : 	View Write Protect Groups Address Map	GPP1 GPP2 GPP3 GPP4 USER

- Write Protect is for the part of chip data, the protection type and protection group are set according to the user's requirements.
- While Analysis of the original chip function: you can check which groups of the original chip was protection set. If you need to set the same write protection group as the original chip, please type in manually.
- When the ECSD file has been loaded, you can check the specific address corresponding to the write protection group.

5.6 EMMC Analysis

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Ka Xgpro v10.75	- 🗆 X
File(F) Select IC(S) Project(P) Device(D) Tools(V) Help(H) Language(L)	
ANTO TO CHECK BLANK BURIFY (READ) + ADD RAM	se (PROC.) (IIII) & About E _{calcu.}
Select IC Information(No Project op	pened)
AUTO EMMC_88_1.8V @BGA153(recommend)	ChilSum: Not Used XG ecu® Dro
Set Interface O ICSP port ICSP_VCC Enable Vcc current Imax:	Befault ▼ © 8 Bits O 16 Bits Save Log Clear
Address 0 1 2 3 4 5 6 7 8 9 A B C	D E F ASCII
<mark>0000-0000:</mark> 00 00 00 00 00 00 00 00 00 00 00 00 00	***************************************
0000-0010: 01 01 00 E0 38 00 00 00 00 00 00 00 00	80 99 908 * Clock Frequence is 8.000 MHZ *
0000-0020: 00 00 00 00 00 00 00 00 00 00 00 00 00	00 00 00
	90 99 90 1Emmc Initialization
	00 00 00 OCR register : COFF8080
<u>8888-8868:</u> AB	88 88 88Successed
	4Read device ECSDSuccessed
0000-0080: 00 01 00 00 00 00 00 00 00 00 00 00 00	00 00 00
8999-8999: 98 99 98 99 98 99 98 99 98 99 98 98 98	E5 00 00 <1> Production Info.and Device life time
0000-00A0: 07 00 01 00 00 00 15 1F 04 00 00 00 00	00 00 00 MTD : 13
0000-0080: 00 02 00 08 00 00 00 02 00 01 00 00 00	00 00 00 PNM : Q2J54A
0000-00C0: 07 00 02 00 57 1F 0A 03 00 00 00 00	08 0B 08 W Product Date : 10-2017
0000-0000: 0C 08 0B 00 00 C0 72 00 0F 13 14 08 08	10 01 11P Version : MMC V5.0/5.01
	88 89 89
	By 05 00 10
	Device life time (PRE_EOL_INFO) : Normal
0000-0120: 00 00 00 00 00 00 00 00 00 00 00 00 0	00 00 00
8888-8138: 88 88 88 88 88 88 88 88 88 88 88 88 88	80 80
<mark>0000-0140:</mark> 00 00 00 00 00 00 00 00 00 00 00 00 00	80 80 BOOTI SIZE : 16384 KB
8888-8158: 88 88 88 88 88 88 88 88 88 88 88 88 8	00 00 00 BOOT2 SIZE : 16384 KB
0000-0160: 00 00 00 00 00 00 00 00 00 00 00 00 00	00 00 00 RPME SIZE : 512 KB
0000-0170: 00 00 00 00 00 00 00 00 00 00 00 00 0	60 60 60 GPP1 SIZE : 0 KB
	90 90 90 GPP3 SIZE : 0 KB
00 00 00 00 00 00 00 00 00 00 00 00 00	GPP4 SIZE : 0 KB
	USER SIZE : 3,760,128 KB
Ext.CSD CID + CSD Authent.Key Options Config	Device.Info
Configuration	
Verify after D Auto SN NUM	
	Analysys IC
Ready Default Program	mmer(1): XGecu T56 0000 0000 //

- Analysis of the original chip is carried out at a lower clock frequency of 8MHZ. You can test whether the connection is normal: If not, try to change the working voltage, or fine-tune the working voltage or select a different bus width for several tests. In that way, for the chips with unstable performance, may be you can get the correct result.
- Connect the adapter or ISP, click button [Analysis IC]
- Click button [SAVE LOG] to save the analysis result
- From the result, you can get the use condition of the chip
 - Display information about the IC's manufacturing
 - Visually display IC use condition of up to 8 partitions
 - On each partition display whether it is write-protected, readable, rewritable or erasable
 - Display whether the entire chip is temporarily write-protected or permanently write-protected
 - Display if the IC is password protected
 - Display whether the IC uses 32-bit authentication key to write for RPMB.
 - Display other important parameters of ECSD CSD CID

Example: The IC analysis results are shown below:

www.XGECU.com

```
<4> -- Write Protection --
ERASE_GROUP_DEF : 00
Disable PERE WP PROTECT : No
1 Programmer Connected.
                                                                                        User Permanent protection: Enable
Whole Chip Permanent Protect : Not protected
Whole Chip Temporary Protect : Not protected
BOOT1 Write Protection Status : Not protected
  Device 1: XGecu T56 Ver: 00.01.37
        USB POWER VOLTAGE: 04.91V
                                                                                        BOOT2 Write Protection Status : Not protected
        USB SPEED MODE: HS 480MHZ
 Write Protect Group Size : 0x800000 | 8192 KB |
  < Analysis IC >
                                                                                        User Write Protection Group (0-Not Protected TE-Temp Protected
                                                                                         WPG Start Addr. 0 1 2 3 4 5 6 7 8 9 10 11 12 13 3
    Pin Detected Passed.
                                                                                        D
                                                                                                                                         0 0
                                                                                                                                               рα
       ****************************
       * Clock Frequence is 8.000 MHZ *
       ****************************
                                                                                        1..Emmc Initialization .....
                                                                                        USER Partiton --- Not any Write Protected . Total Write Protect
               OCR register : COFF8080
       2...Read device CID .....Successed
                                                                                    <5> -- other Informations --
       3..Read device CSD .....Successed
       4...Read device ECSD ......Successed
                                                                                        MAX_READ_BL_LEN : 512 bytes
MAX_URITE_BL_LEN : 512 bytes
MAX_TRAN_SPEED : 55.000 MHZ
  <1> -- Production Info.and Device life time--
                                                                                        ENH START ADDR
                                                                                                                    : 00000000
       MID
                       : 13
                                                                                        ENH_SIZE_MULT
MAX_ENH_SIZE_MULT
                                                                                                                     000000
0000E5
       PNM
                       : Q2J54A
                                                                                        PARTITIONS_ATTRIBUTE
                                                                                                                    : 00
       Product Date : 10-2017
                                                                                        WR_REL_SET
WR_REL_PARAM
                                                                                                                      1F
       Version
                   : MMC V5.0/5.01
                                                                                                                      15
                                                                                        PARTITION_SETTING_COMPLETED : 00
       Device life time Type A : 0%-10% device life time used
                                                                                        HC_UP_GRP_SIZE : 10
HC_ERASE_GRP_SIZE : 1
WP_GRP_ENABLE : 1
WP_GRP_SIZE : 15
NP_GRP_SIZE : 15
                                                                                                         : 16
       Device life time Type B : 0%-10% device life time used
       Device life time (PRE EOL INFO) : Normal
                                                                                                          : 15
                                                                                        ERASE_GRP_NULT
                                                                                                          : 31
  <2> -- Partition Size Info.--
                                                                                        ERASE GRP SIZE
                                                                                                         : 31
                                                                                        ccc
                                                                                                          : 0075
       BOOT1 SIZE : 16384 KB
BOOT2 SIZE : 16384 KB
                                                                                        DSR implemented
                                                                                        PARTITION_ACCESS : 30 mm
                                                                                        ERASED_MEM_CONT
DYNCAP_NEEDED
SECURE_WP_INFO
                                                                                                          : 00
       RPMB SIZE
                       : 512 KB
                                                                                                            ۵۵
                                                                                                         : 00
       GPP1 SIZE
                       : O KB
                                                                                        SEC_ERASE_NULT : 10
ERASE_TIMEOUT_MULT: 11
NATIVE_SECTOR_SIZE: 00 (5128)
                      : O KB
       GPP2 SIZE
       GPP3 SIZE
                       : O KB
                                                                                                         : 100DO ma
                                                                                        INI_TIMEOUT_AP
INI_TIMEOUT_ENU
       GPP4 SIZE
                       : O KB
                                                                                                             : 0 mə
       USER SIZE
                       : 3,760,128 KB
                            ( 0x 00 E580 0000 )
                                                                                    <6> -- Result -- View More Information in ECSD and CSD
  <3> -- RPMB Security and Password --
                                                                                        1 . BOOT1 Partition Not be Permanent write-protected, it can be 2 . BOOT2 Partition Not be Permanent write-protected, it can be

    GPD1 GPD2 GPD3 CPD4 The Partition Investid
    GPD1 GPD2 GPD3 CPD4 The Partition Investid
    USER Partition Not be Permanent write-protected, it can be
    RPMB Partition is Slank, not be Used.
    This chip's content can be completely copied to another ch:

       Authentication Key not yet programmed, RPMB not used
       Password Protect Features : YES
       Password Protected
                                        : Not Locked
```

5.7 Read EMMC

- Select IC (example: JY001_8bits, this is a 4GB IC)
- Set the folder for data storage in [Operation Options] (EMMC_DATA, you can set it arbitrarily)
- Don't need to change any other settings, just click [Read] button to start reading.

Reading results as below:

Xgpro Software User Guide -T56/TL866II

Sex Xgpro v10.75		
File(F) Select IC(S) Project(P) Device(D) Tools(V) Help(H) Language(L)		
ADD RAM LANK READ + ADD RAM LANK	PROG. CALCU.)-Y
_Select IC	ned)	
AUTO EMMC_8B_1.8V @BGA153(recommend)	(Sum: Not Used 5GB	
Set Interface ICSP_VCC Enable Vcc current Imax: 	Default 💌 💿 8 Bits 🔿 16 Bits	
Chip Read APP Version: 10.75		
MODEL AUTO EMMC 8B 1.8V	cket	
Use Adapter: ADP-BGA169-EMMC Save Log	BGA153/169 (TOP View)	
Verify Restart EMMC Init EMMCOKI (OCR register: C0FF8080) Verifing CSD Succeeded Verifing BOOT1 : Succeeded. Time : 0.718 S Partition Size :16384 KB Process: Verifing BOOT2 : Succeeded. Time : 0.718 S Partition Size :16384 KB Process: Verifing BOOT2 : Succeeded. Time : 0.718 S Partition Size :16384 KB Process: Verifing User Area : Succeeded. Time : 32. 16 S Partition Size :3760128 KB(F Verifing Succeeded 32 bits CheckSum : 0x 4BD26360 Reading +Verifing Succeeded Total Time : 3 M 26 S Saved ONE_KEY_GHOST project to file: D:Wgpro/UserData/emmc_d2/EMMC_Ghost.mpi Read Result Verifing Succeeded 100% Verifing Succeeded Verifing Succeeded ZI	С С С С С С С С С С С С С С С С С С С	

- 4GB IC, the total time to "Read + Verify" is 4 minutes 28 seconds, this is a more typical time for actual operation for your reference. Generally, the IC of more larger capacity will get the faster reading and writting speed.
- After reading is finished, an EMMC_GHOST.mpj project file is automatically generated as shown above, just open this
 project when programming.

After reading, the contents of the folder are as below: at least 5 files will be generated, one of which is a one-key-ghost project file. If IC uses RPMB or GPPx, there will be more files.



Note: Before reading, it will check the remaining capacity of the disk, if the capacity is not enough, select the data folder in the operation options and save it to another disk

5.8 Program EMMC : one-key-ghost example

One-key copy of new IC read in the previous section

Just open the project file [EMMC_GHOST.mpj] previously read and copy it with one key.

5.8.1 Select IC (for example: JY001_8bits)

How to select IC correctly, you can refer to the previous contents.

5.8.2 Click [Open Project] in Project Menu

🜆 Xgpro v10.75				
File(F) Select IC(S)	roject(P) Device(D) Tools(V)			
DANTO TOCHECE BLANE	Open Project(O)			
Select IC	Save Project(B) Save Project As(S)			
JYC	Close Project(C)			
Set Interface • ZIF socket	Project attrib(A) Modify Password(K)			
▶ 打开工程文件				×
← → ✓ ↑	ro > UserData > Emmc_data	~ Õ :	搜索"Emmc_data' E==	·
🔜 氣面 🛷 ^	名称 ^	修改日期	类型	大小
 ▶ ▶ 文档 ■ ■ B 360安全浏览 ■ Emmc_data IMG2 PLUS_DATASHE ■ 此电脑 30 対象 	EMMC_Ghost.mpj	2021/1/23 16:28	MPJ文件	14
 ■ 视频 ■ 関片 ☆档 				
文件名()	N): EMMC_Ghost.mpj	~ [Project files(*.mp 打开(O)	əj) ~ 取消

After clicking [Open], the project has been loaded

5.8.3 Program new IC (done by one key)

Don't need to make any other settings, at this time the data folder, ECSD, CSD and other operation options have all been set automatically, directly click **[PROG.]** button to copy and program.

Note: For projects that need to program the RPMB partition, please see section 5.8.4 for details

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🔯 Xgpro v10.75				- 🗆 ×
File(F) Select IC(S) Project(P) Device(D) Tools(V)	Help(H) Language(L)			
AUTO TO CHECK BLANK BURIFY READ	+ ADD RAM	РКОС. 🥮 🎖 АВОИТ		
_Select IC	IC Information(No Project opened	t)(t		
AUTO EMMC_8B_1.8V @BGA153(recommend)	ChipType: EMMC ChkSu	m: Not Used	X	Gecu [®] Pro
_ Set Interface		,		
© ZIF socket © ICSP port □ ICSP_VCC 8	Enable Vcc current Imax:	efault 💌 💿 8 Bits	O 16 Bits	Save Log Clear
Address 0122456	7 0 0 4 0 C D	Е Е АССП	Dovigo lifo	Fime (PRE_EOL_IN A
Chip Program APP Version: 10.75				Info
	MARAC OD 4 OV	Location in Socket		
0000-0030: MODEL: ADIOE	WIWC_0D_1.0V			84 KB 84 KB
0000-0040: Use Adapter: ADP-BGA	169-EMMC Save Log	· · · ·	BGA153/169 (TOP View)	KB
Analysis file is complete, Space usage: 3. Programming User Area : Succeeded. Time	73% time: 20S e : 31.735 S Partition Size :3760128		1 000000000000000	(B)
Programming ECSD Succeeded. Time : 10) ms			.B
BOOD-0980: Programming 32 bits CheckSum : 0x 4BD2	.6360			B
6699-6996: Verify Restart EMMC	i0)			0,128 KB
Verifing CSD Succeeded	- /			
Verifing BOOT1 : Succeeded. Time : 0.734	S Partition Size :16384 KB Proces:			ind Passwor
Verifing BOOT2 : Succeeded. Time : 0.719 Verifing User Area : Succeeded. Time : 10	IS Partition Size :16384 KB Proces: 0.937 S Partition Size :3760128 KB(not yet p
0000-00E0: Programming Verifing Succeeded 32 bits	CheckSum: 0x 4BD26360			estures .
6000-0100:	148 5			
<u>8699-0110:</u>	>		000000000000000000000000000000000000000	
0000-0120: Programming EM	MC : Succeeded		PIN A1#]
8688-6148: 100%				: O
0000-0150: View Adpter	Program BACK	ZIF48		ROIECI : N *
Ext.CSD		,		
	IC Config Informaton			
Pin Detect 🔲 Check ID	\ \			
🗖 Erase before		Erase/Prog	ram/verify by one key	
🗆 Verify after 👘 Auto SN_NUM				
🗖 Skip Blank 🛛 Addr.Range: 👁 ALL 🔿	Sect		[Analueus IC
□ Blank Check 0x 00000000 -> 000			L	Anarysys IC
Ready	Default Programmer	(1): XGecu T56		0000 0000

Programming process as shown above, "Program + Verify" total time of 0 minutes and 48 seconds, it is faster than reading, because the blank data was skipped when programming.

The new chip copy is completed.

5.8.4 One-key-ghost project notes:

- When programming the project, the capacity of the BOOT, RPMB, and USER partitions of the original chip will be compared with that of the programmed chip. If the capacity of the new chip in any one partition is smaller than the original chip, will stop programming.
- When programming the project, the EMMC version of the original chip and the new chip will be compared. If the version of the new chip is lower than that of the original chip, the programming will be stopped.
- For projects that need to program RPMB partitions, the correct 32-byte authentication key is required. The user can load the
 authentication key in the File menu after opening the project, and save the project after loading. This authentication key will be
 used as the new authentication key when programming the RPMB. (Authentication key can also be loaded before reading.
 Save to project file when saving a project automatically with key.)
- If the authentication key is not loaded, when programming, the all-blank data 0xFF will be used as the authentication key.
- Important Note: authentication key, one chip is only allowed to be programmed once, it cannot be read and cannot be erased.
 If the authentication key is lost, the RPMB data will be permanently immutable. For specific devices, incorrect authentication key will not pass.
- If new chip's RPMB has been used when programming, but there is no authentication key, it will prompt key error. At this time,

the RPMB data cannot be programmed. If you have correct authentication key, the RPMB can be programmed normally.

5.9 EMMC ISP in-circuit programming example

EMMC in-circuit programming is an important and convenient application in the home appliance repair industry. T56 programmer through ISP programming, the rate reached to 40Mb / S (single line transmission measured: 4.7M bytes / second), ISP cable length up to 40CM, that is extremely high stability and high speed. For common TV motherboard 4GB IC, the read time is only about 800 seconds.

Note: working frequency setting is 36MHZ by default. Via ISP, it can be set to 40MHZ in most of cases.

5.9.1 EMMC ISP connection

ISP Schematic Diagram



In general, 1bits only need to connect GND / CLK / CMD / D0 to the motherboard, then power the motherboard.

Notes:

- ISP has two grounds, both grounds need to be connected, and the ground point should be as close to the CLK line as possible.
- CLK line and the two GND lines do not separate, and CLK line should not cross with other lines, CLK line generally has a series of resistors R, you had better remove it.
- Both ends of the crystal of the MCU in PCB, connected to ground, stop the MCU from working.
- Connect the lines, power up the motherboard and check if the RST_n pin of the EMMC is high. If the RST_n voltage is 0, you
 need to pull up the pin, otherwise EMMC will not work. You had better connect 1K resistor to VCCQ (1.8V or 3.3V). This pin is
 the reset pin of EMMC.
- When power is supplied through external power supply, the computer and the external power supply's casing are must be reliably connected to the earth (anti-static interference)

Note: When the ISP is powered by programmer and ISP_3.3V is checked, the VCC and VCCQ pins of programmer will be powered at 3.3V. When ISP_1.8V is checked, the programmer is only for VCC 3.3V, VCCQ high resistance state, VCCQ 1.8V needs external power supply.

EMMC BGA153/169 IC PINS:

ſ

	0AT2 (RFU) (RFU) (NC) (N	
(NC) DATE DATE DATE	DATE DAT7 (NC) (NC) (N	C) (NC) (NC) (NC) (NC) (NC)
(NC) (VD) (NC) (VSSQ)	(RFU) (Vccg) (NC) (NC) (N	(NC) (NC) (NC) (NC) (NC) (NC) (NC)
$\langle (NC) (NC) (NC) (NC) (NC)$		$\left(\underbrace{NC} \right) \left(\underbrace{NC} \right) \left(\underbrace{NC} \right)$
	(RFU) (V _{CC}) (V _{SS}) (RFU) (RF	
(NC) (NC) (NC)	Vcc	(\overline{RFU}) (\overline{NC}) (\overline{NC}) (\overline{NC})
(\mathbf{NC}) (\mathbf{NC}) (\mathbf{RFU})	V ₅₅	(\overline{RFU}) (\overline{NC}) (\overline{NC}) (\overline{NC})
(NC) (NC) (NC)		V_{SS} (NC) (NC) (NC)
(\overline{NC}) (\overline{NC}) (\overline{NC})		Vcc (NC) (NC) (NC)
(NC) (NC) (NC)		$(\overline{RFU}) \qquad (\overline{NC}) (\overline{NC}) (\overline{NC})$
		(\overline{NC}) (\overline{NC}) (\overline{NC})
(\overline{NC}) (\overline{NC}) (\overline{NC}) V_{CCO}		C (NC) (NC) (NC) (NC) (NC) (NC)
	V_{SSO} (NC) (NC) (NC) (NC)	$(\mathbf{N}^{2}) (\mathbf{N}^{2}) (\mathbf{N}^{2}$
(NC) (NC) Vccg Vssg	Vccq Vssq (RFU) (NC) (N	$C_{\rm red}$ (RFU) (NC) (NC) (NC) (NC) (NC)

The following photo shows the wiring example of the MSD6A638-T8F1 TV board:



5.9.2 Select IC and Analysis IC

🌆 Xgpro v10.75		
File(F) Select IC(S) Project(P)	Device(D) Tools(V) Help(H) Language(L)
DAUTE CHECK DELANK DEVELTY (READ)	+ XDD RAM Strass PROG.	W RADUT CALCU. BED-7 IV
Select IC		IC Information(No Project opened)
AUTO EMMC(ISP)_1B_1.8	3V(recommend)	ChipType: EMMC ChkSum: Not Used IC Size: Auto 0GB - 256GB
Set Interface C ZIF socket ICSP po	ort 🗹 ICSP_VCC Ena	able Vcc current Imax: Default 💌 @ 8 Bits C 16 Bits
Select Device		
Search Device	fanufactory	Device
AUTO EMMC Type • ALL C ROM/FLASH/NVRAM C MCU/MPU C PLD/GAL/CPLD C SRAM/NVRAM C NAND C EMMC/EMCP C VGA/HDMI XGecu ®	070	AUTO: EXEC: 18.1 1.4.0/1620/cme3cd) AUTO: EXEC: 18.7 1.8.3 AUTO: EXEC: 18.1 1.8.4 AUTO: EXEC: 18.1 1.8.4 AUTO: EXEC: 40.1 1.8.4 AUTO: EXEC: 40.1
Automatic Identification	IC Total: 26022	Select Cancel

- Type in "AUTO EMMC"
- Select AUTO_EMMC(ISP)_1B_1.8V
- Click <Analyze IC>button and check if the connection is normal. If there is no problem, will go to the next step

5.9.3 ISP read data from original IC

Before reading, set 40MHZ as the operating frequency in the operation options and click button [Read] in the toolbar.

Verity Arcer Frogrammi	ny or keau.		71
🖌 Select Clock	40 MHZ		
🔽 Select Power voltage	VCC=3.3V/VCCQ=1.8V		
✓ Select Power voltage Chip Read APP Version: 10.75 MODEL: AUTO EMMC(ISP)_ Init EMMCOKI (OCR register: COFF8080) Reading ECSD : Succeeded Authentication Key not yet programmed, R D:Calcu available disk capacity: 193 GB Reading BOOT1 : Succeeded. Time : 0.454 S - Reading BOOT1 : Succeeded. Time : 0.438 S - Reading User Area Keading User Area View ICSP Connection	1B_1.8V(recommend) Save Log PMB not used - Partition Size :2048 KB - Partition Size :2048 KB rea 4.7 MB/S read	Location in Socket T56 Programmer 1 2 3 4 5 6 7 8 8 D3(used 4Bits) 7 D2(used 4Bits) 6 D1(used 4Bits) 5 D0 4 CMD 3 Gnd 2 CLK 1 Gnd if Bus 1 bits, D1/D2/D3 not used	

The reading process is shown in the figure above, the stable reading speed is 4.7MB/s at 40MHZ operating frequency. Reading speed is 4.1MB/s at 36MHZ, if there is the error, frequency can be properly reduced.

Chip Read APP Version: 10.75	
Chip Read APP Version: 10.75 MODEL: AUTO EMMC(ISP)_1B_1.8V(recommend) Save Log Verify Restart EMMC Int EMMC OK! (OCR register: COFF8080) Verifing CSD Succeeded Verifing BOOT1 : Succeeded. Time : 0.437 S Partition Size :2048 KB Processi Verifing BOOT1 : Succeeded. Time : 0.437 S Partition Size :2048 KB Processi Analysis file is complete, Space usage: 3.62% time: 24S Verifing Succeeded. Time : 54.297 S Partition Size :3866624 KB(Verifing Succeeded. 32 bits CheckSum : 0x 4BD26360 Reading +Verifing Succeeded. Total Time : 14 M 43 S	T56 Programmer 1 2 3 4 5 6 7 8 8 D3(used 4Bits) 7 D2(used 4Bits) 6 D1(used 4Bits) 5 D0 4 CMD
Saved ONE_KEY_GHOST project to file: D:\Xgpro\UserData\emmc_d2\EMMC_Ghost.mpj	4 — CMD 3 — Gnd 2 — CLK
< > Reading + Verifing Succeeded	1 — Gnd if Bus 1 bits. D1/D2/D3 not used
100% View ICSP Connection Read BACK	

- The total time for "Read + Verify" the 4G IC is less than 900 seconds. The verification time is particularly short because the IC takes up very little space.
- Also saved one-key ghost project file, only need to open the project file when copying, the specific method is the same as in section 5.8.

5.9.4 ISP program IC

- *Select IC AUTO_EMMC(ISP)_1B_1.8V
- *Open the one-key clone project file read
 Under normal condition, open the project file and program all the data read from EMMC to finish the copy with one key.
 If you don't need to program all the data, please uncheck the option that you don't need to write.
 Another method: After selecting IC, do not use the project file, just select the data folder. Check the area to be programmed in the operation options, that is completely set by user
- Click [PROG.] button in the toolbar to start programming IC

Open Project

5 Xgpro v10.75	
----------------	--

File(F) Select IC(S)	Project(P) Device(D) Tools(V
DAUTO TOCHECK BLANK	Open Project(O)
Select IC	Save Project(B)
	Save Project As(S)
	Close Project(C)
Set Interface	Project attrib(A)
C ZIF socket	Modify Password(K)

Open project file: EMMC_GHOST.MPJ

🐻 打开工程文件			×
$\leftarrow \ ightarrow \ \checkmark \ 1 \ \$ Xgpro $\ ightarrow \ UserData \ ightarrow \ \$ Emmc_data	∨ ∂ 搜索	萦"Emmc_data"	م
组织 ▼ 新建文件夹			• •
桌面 	修改日期	类型	大小
 下號 ○ 文档 ○ 図片 ○ 360安全浏览器 ○ Emmc_data ○ IMG2 ○ PLUS_DATASHE 	2021/1/23 16:28	MPJ 文件	14 K
 ■ 10-644 ③ 3D 对象. 圖 视频 ■ 图片 登 文档 ✓ < 文件名(N): EMMC_Ghost.mpj 	→ Pr	oject files(*.mpj) 打开(O)	▶

Click [PROG.] on toolbar

The whole programming process, as shown below, Erase, Program and Verify all partitions with one key.

Chip Program APP Version: 10.75	- Location in Socket
MODEL: AUTO EMMC(ISP)_1B_1.8V(recommend) Save Log Analysis file is complete, Space usage: 3.62% time: 21S Programming User Area : Succeeded. Time : 53.734 S Partition Size :3866624 Programming ECSD Succeeded. Time : 10 ms Programming S2 DS Ducceeded. Time : 0 ms Programming 32 bits CheckSum : 0x 4BD26360 Verify Restart EMMC Init EMMCOK! (OCR register: COFF8080) Verifing ECSD Succeeded Verifing BOOT1 : Succeeded. Time : 0.437 S Partition Size :2048 KB Processi Verifing BOOT2 : Succeeded. Time : 0.422 S Partition Size :2048 KB Processi Verifing User Area : Succeeded. Time : 30.16 S Partition Size :3866624 KB(F) Programming Verifing Succeeded 32 bits CheckSum : 0x 4BD26360 Programming Verifing Succeeded 32 bits CheckSum : 0x 4BD26360 Programming Successful! Total Time : 1 M 26 S Image: Image	T56 Programmer 1 2 3 4 5 6 7 8 8 D3(used 4Bits) 7 D2(used 4Bits) 6 D1(used 4Bits) 5 D0 4 CMD 3 Gnd 2 CLK 1 Gnd if Bus 1 bits, D1/D2/D3 not used

[END of EMMC]

6. NAND/SPI_NAND Programming

T56 supports up to 256G bits NAND flash, supports BGA and TSOP packages and SPI NAND TL866II only supports TSOP48 chips with less than 8G bits (1G bytes) capacity

6.1 Characteristics of NAND FLASH

- NOR Flash randomly accesses all memory maps and dedicated interfaces (such as EPROM) address and data lines. But
 there is no dedicated address line in NAND flash. It is made up of an 8/16-bit wide interface bus that sends commands,
 addresses and data to internal registers, that provides a more flexible configuration for many original chips. The NAND flash
 architecture, emphasis on lower cost per bit, higher performance, and disk can easily upgrade through the interface, NAND is
 lower cost and higher capacity.
- NAND, bad blocks are allowed. Due to the production process of NAND, bad blocks will randomly appear in the factory chip.
 Bad blocks are initialized at the factory and marked as bad blocks in the special area. If bad blocks appear during use, they also need to be marked.
- Bit flip: If bit flip occurs on critical files, it will cause the system to hang up. Therefore, while using NAND FLASH, algorithms such as ECC/EDC must be used for data correction to ensure reliability.
- There is spare area. Just because NAND FLASH has the above two special features, spare area plays the role of putting bad block flags, ECC values, IC information and file information.
- NAND FLASH bad blocks manage: There are many ways to manage bad blocks in NAND FLASH. Different system providers
 may choose different management methods of bad block to meet the needs of product development. The software defines
 three common methods for user to choose from. The software defines three common methods for users to select and use,
 and enables user-defined ECC algorithms for flexible applications.

6.2 Structure of NAND

The following figure shows the MT29F4G08ABAEA as an example:

MT29F4G08 has 2 Planes *2048 blocks , the programmer is operated in blocks, index number 0-4095 blocks. Each block has 64 pages , and the processing of each block is separately written to the chip sequentially.

The size of each page: 2048 bytes (Page size) + 64 bytes (Spare size) = 2112 bytes

The total capacity of IC is: 2112 * 64 (Page) * 4096 (Block) = 4224MB.





6.3 NAND Program main interface

After selecting IC, the software interface is as below:

🜆 Xgpro v10.75			_																				-	
File(F) Select IC(S) Pr	oject(l	P) [)evic	e(D)	Tool	s(V)	Helpi	(H)	Lang	uage	(L)												
🖻 LOAD 🛛 🔚 SAVE	Ð	AUTO	۹C	F	Read.	.(R)						+	ADD	R	AM	a	rase PROG.) 🗇	?	ABOUT	CALCU.	Å⊒€≻	- ү ТУ	
Select IC	2		_	F	Read I	D(I)					h(No	Proje	ect op	enec	d) —— (b									
MTOOFIC		E 0.54/E	_	V	/erify	(M)					NAN	D	Ċ	hkSu	m: N	ot Us	ed					-	R	-
M129F1G	JBABA	EAVVE		P	rogra	am(P)					Ox0	00_08	34000	00 B)	ytes 1	.3516	8 KB					XG	ecu~	Pro
-Set Interface -	<u> </u>		_	E	rase	(E)									<i>c</i> 11									
© ZIF socket	0	ICSP	por	B	lank	Check	(B)				ic cu	rrent	Imax:	םן	efault		⊙ 8 Bit	s O 16	Bits				Save L	.og Clear
Address	0	1	2	S	erials	Num	ber				A	B	C	D	E	F	ASCII	ach I			******	******	******	******
0000-0020:	4E 00	41 00	41 0	Т	esting	a		- 3	3		20	49 00	00 22	DE	00 A8	00 A2		·····			1 Programmer	Connec	ted.	
0000-0040:	50	00	4	_				/			00	00	00	00	50	78	Ρ.@		.Px		Newice 1. X	'******* 'Gecu T9	:******* 56 Wer:	
0000-0050:	00	00	Ø	P -	viulti F	rog.	-				00	00	00	00	5F	CO			· _ ·		USB PC	WER VOI	TAGE: 0	00.01.01
0000-0060:	B2	5A	0	r	NAND	Bad	Block	Chec	ĸ		06	9F	10	02	00	00	-2				USB SF	EED MOI	E: HS 4	SOMHZ
0000-0070.	00 54	68	7	L	ogic l	Cles	st				20	99 31	34	30	34	32	Thu Mar	12 14	:42		**********	******		
0000-0090:	3A	35	3	T	V/LCI	D Too	ls				31	35	ØA	00	00	00	:54 CST	2015.			PageSi	ze : 2	:048	
0000-00A0:	00	AA	00	AA	00	AA	00	AA	07	00	00	00	83	46	69	44			FiD		SpareSi	.ze: 6	54	
0000-00B0:	00	00	00	01	A1	86	74	FØ	1D	22	87	C2	81	04	06	9F	t	"			Pages Fer Blo Blocks Si	ck: t 78 • 1)4 28178 ∔	4VB
0000-0000:	48	69	04	03	42	28	60	15	88	88	00	00	88	88	88	88	HiB(`				Total Bloc	ks : 1	1024	IND
0000-00D0:	00	00	00	00	00	00	00	00	10	02	00	00	00	00	10	07			ς		Device Si	ze : 1	.28MB +	4096KB
0000-00E0:	01	00	00	00 00	40	20 00	00	00 07	00	40	00	00	00 00	00	00 00	00	ae .				Bus Wid	lth : 8	3	
0000-0100:	00	66	00	00	00	66	00	00	00	AA	00	AA	66	AA	66	AA					nCL# F nRB# F	'in : 1 'IN : 1	<u>.</u> 1	
0000-0110:	07	00	00	00	41	44	17	22	00	00	00	00	61	86	74	FØ	AD.'	'a	.t.					
0000-0120:	73	12	00	40	81	04	ØA	9F	2F	69	04	03	42	28	60	15	s@	./iB	(`.					
0000-0130:	88	88	00	00	88	88	88	88	00	00	00	00	00	00	00	00								
0000-0140:	00	00	00	00	00	00	10	07	63	1B	00	00	00	20	00	00		.c						
0000-0150:	00	40	00	00	00	68	00	00	88	00	00	99	99	99	00	00	.d							
0000-0100.	00 00	ยย F1	00	ออ คด	00	ยย ดด	00	ยย ดด	ยย ดด	00 ดด	00	ออ ดด	00 88	00	00 ពព	00					/			
Block ()	Ur	nique i	ID	T	Opti	ons		Device	e.Info												-			,
_Options											onfia	Infor	mator			Bloc	k @File:	0			- 5			
			_			~					oring	1111011	nator	1			Note: cli	-k the ur	and c	lown	arrows to browse t	he data o	f the previ	ious block or
Pin Detect			MC	:heck	ID		4										the next	block					i dio provi	
Erase before			_																					
Li Verity atter				uto (SN_NC	JM 	~														6			
Rief: Select (CS) Project(P) Device(D) Tools(A) Help(H) Language(L) Rief: Select (CS) Project(P) Read.(R) <					(ONFI)																			
El Blank Check			Ox [0000	0000] ->	000	00000																
												_												
										Defa	ault	Pro	gran	mer	(1):	XGe	cu T56						0000	0000 /

- 1) Click select button to select IC model
- 2) Load and save: data files to load or save to file after reading
- 3) <NAND bad block check> function in the menu is only valid for standard bad block markers, for a small amount of specific device data, if the bad block marker is not standard, the check result is not accurate, you can ignore it.
- 4) Configuration and options: configuration of NAND programming method, see the next section for details: configuration and options (for equipment maintenance personnel, generally settings by default, do not need to change)
- 5) Data block switch: user browse the data buffer by block, after loading file or reading IC, user can use the software to directly browse the data in the set block.
- 6) ONFI automatic identification of IC parameters: the IC model not listed in the software, for the NAND chip in line with the ONFI standard, the user can use this function to automatically identify the chip parameters, automatically adjust the software parameters after identifying. You can read and write directly, and can be saved as a customized IC model, see Chapter 10 Add customized IC for details.

6.4 NAND Configuration and Options

Click [Options] button in Figure 4 to enter the programming configuration interface.

6.4.1 Programming Operation Options

Settings when reading or programming

Prog. Speed: if an error occurs during reading or programming, please try to select "Low Speed".

-1. Operation Options		
n operation optione		
🖌 Erase Before Programming	Prog.Speed:	(Default
Not clear Bad Block Mark when Erase		🔘 Low Speed
Skip Blank		🔿 High Speed
🖌 Auto Verify after reading or Programming		
Blank Check Before Programming		
Read Device Unique ID (UID)		

6.4.2 Bit flip Permission

Set by the required ECC error correction bit, usually set by default, no need to modify.

Note: When reading or writing to the chip, the NAND will be bit flipped, so the data file read may not be exactly the same every time. The file data is valid as long as the auto-verify passed when reading, that means the error data is in allowed range.

-2 Bit Elin Pormission		
2. Dit inp i crimasion		
C 1bits/512B C 4bits/512B	C 8bits/512B	

6.4.3 Customize NAND parameters

The software allows user to set NAND parameters according to the IC data sheet. Theoretically, user can add any NAND IC by customize setting, see Chapter 10 Adding Custom IC for details.

3. Customize NA	ND param	eters					
Customiz	e Setting	a					
Page	e Size :	4096	v	VCC Voltage	:	3.0V	•
Spare	e Size :	224	.	Bus Width	:	8 Bits	v
Pages per	Block :	64	v	PIN CONFIGURATION	:	ONFI STD	T
BlocksPer#C	CE(Die):	2048	_	PACKAGE	:	TSOP48	T
#CEn	(Die) :	1	_	Internal ECC	:	Disable	_
#RBn	Pins :	1	T	Device ID :		2C DC	
	View	Config R	Resault				

6.4.4 File name/ Path/ Partition Assigned

Cempor D:\Xg1	Data c ary Buffe pro_T56\U;	ccess met! :r Floder: serData\NA	nod: (• 3: (• 5: (• M) ND	ingle File Mode ,All Datas ingle File,Partitions Mode altiple Files and Partitions	Calcu. CRC Set Buffer Fl	32 loder
PART.	ST_BLK	END_BLK	CNT_BLK	File		
1	D	99	90	D:\Xgpro_T56\UserData\NAND\Part	_1.bin	
1 2	100	199	95	D:\Xgpro_T56\UserData\NAND\Part	_2.bin	
3	D	D	D	D:\Xgpro_T56\UserData\NAND\Part	_3.bin	
4	D	D	0	D:\Xgpro_T56\UserData\NAND\Part	_4.bin	
5	D	D	D	D:\Xgpro_T56\UserData\NAND\Part	_5.bin	
6	D	D	D	D:\Xgpro_T56\UserData\NAND\Part	_6.bin	
7	D	D	D	D:\Xgpro_T56\UserData\NAND\Part	7.bin	
Ξ.i	n			D:\Xopro T56\UserData\NAND\Part	. 8.bin	

6.4.4.1 Temporary Buffer Folder

The folder where temporary files are stored when a single file is accessed.

NAND files may take up a lot of disk space. Only while the capacity of disk is low, you need to set the folder to another disk, normally no changes are needed.

6.4.4.2 Data access method

- Single file Mode, all data: all data is from a single buffer file when programming, or stored in single buffer file when reading., generally uses this mode by hard copy.
- **Single file, partitions mode:** data is from a single buffer file (user loaded) when programming, or stored in the buffer file when reading. When programming or reading, the data is handled by partition.
 - PART: Select the partition to use
 - ST_BLK: Start block of partition
 - END_BLK: End block of partition
 - CNT_BLK: The number of data blocks in the file for current partition (the actual number of data blocks be processed)
 Note: The size of the partition (END_BLK-ST_BLK+1) must be larger than CNT_BLK when setting.

The next partition memory cannot overlap with the previous partition.

• Multiple files and partitions: Partition mode is the same as the above, but each partition uses its own file, which does not use the buffer file.

In mass production, the NAND partition mode is generally used for bad block skipping process, which can be set by user as needed, see Bad Block Management for details.

6.4.5 Set OTP Area

Only T56 programmer can support OTP

Some NAND has a special OTP area where data can be written, generally used to store the serial numbers. fixed or unchanging data, etc. OTP is the abbreviation of "One Time Programmable", that means one-time programmable. Once the data in this area has been programmed, it cannot be programmed again.

When reading the original IC, you can check this option, after reading, check whether the OTP data file data is completely empty. If there is data, OTP data must be written to the new NAND together when copying.

-5. Set OTP Area	
Read or Programming OTP are	
OTP PROTECTED After Programm	Select OTP data file
D:\Xgpro_T56\UserData\NAND\OTP_data.bin	
OTP Pages Per Die : 0	

OTP data file: Disable or enable OTP

OTP pages: refers to the maximum number of pages in this area, only the smaller number of pages can be set.

6.4.6 Spare Area in the File



Due to the special nature of NAND FLASH, the data file is whether it includes the spare data. If not included: the file will not include the spare area data

6.4.7 Bad Block Manage Mode

3 manage modes for bad block



6.4.7.1 Skip Bad Block

If a bad block is found during reading or writing IC, the programmer will skip the bad block. And directly proceed to the next block. as below:



6.4.7.2 Hard Copy

Force data reads or writes regardless of whether the block is marked with a bad block or not. If the verifying displays error during writing, programming will be stopped. This method is generally used for technical maintenance when replacing memory chips.

6.4.7.3 Replace Bad Block

Bad blocks are found to be written to the beginning of a specific block set, that allows the system to logically feel that the memory is still a contiguous area, and is generally used in partitioning mode.

See detailed instructions in the example configuration as below. The number type in the start block (example: 900) is the actual replacement block index that is written to FLASH when the bad block is found.

6.4.7.4 Enable user-defined algorithm file

In the customized algorithm DLL file, before programming user can perform data processing or automatic sequence number calculation for any data in the block, as well as perform ECC algorithms, etc. It is also possible to auto-fill the BBT table with data according to the skipped bad blocks during programming.

For details, please contact us and we can customize it according to your requirements.

6.4.8 Configuration Example 1 (MT29F1G08ABAEA)

Operation method: single file, partitions mode, skip bad block

- 1) program NAND FLASH with partition
- 2) bad block processing mode: **skip bad block**
- 3) File data: file includes spare area data.
- 4) Use 2 partitions:

The first partition: from 0# to199#, a total of 200 blocks, the actual length of the written data is 10 blocks The second partition: from 1000# to 1023#, a total of 24 blocks, the actual length of written data is 5 blocks After the above settings, you can start programming. The results of the operation are shown in Table 1-2.

If the length of the buffer file is not enough, the programming is terminated.

If the buffer file length exceeds the length of the BLOCK (Total 15 blocks) data to be written, the programming is terminated. The configuration interface is shown as below:

Tempor D:\Xgr	Data a ary Buffe ro_T56\Us	ccess met) r Floder: serData\NA	ND	ingle File Mode ,ill Datas ingle File,Fartitions Mode ultiple Files and Partitions	Calcu. CRC32 Set Buffer Floder
PART.	ST_BLK	END_BLK	CNT_BLK	File	
🗹 1	0	199	10	D:\Xgpro_T56\UserData\NAND\Part	1.bin
2 2	1000	1023	5	D:\Xgpro_T56\UserData\NAND\Part_	2.bin
3	0	0	0	p:\Xgpro_T56\UserData\NAND\Part_	3.bin
4	0	0	0	D:\Xgpro_T56\UserData\NAND\Part_	4.bin
5	0	0	0	D:\Xgpro_T56\UserData\NAND\Part_	5.bin
6	0	0	0	D:\Xgpro_T56\UserData\NAND\Part	6.bin
7	0	0	0	D:\Xgpro_T56\UserData\NAND\Part	7.bin
	0	0	0	D:\Xgpro T56\UserData\NAND\Part	8.bin

Table 1-2: Programming Process diagram

Buffer File		NAND Flash
File Start		
2112x64 bytes		0# Block
2112 x64 bytes		1#6# block
*6 blocks	Partition 1	
2112 x64 bytes	Skipped	7# Bad Block skipped
2112 x64 bytes		8# block
2112 x64 bytes		9#
2112 x64 bytes		10# 10 blocks end
2112 x64 bytes	Boutition 2	
2112 x64 bytes	Paulilion 2	
2112 x64 bytes		1000# Block 2th Partition start
2112 x64 bytes		1001#
		. 1002#
		1003#
		1004# Bab Block Skipped
		1005#
	-	

Notes:

In this configuration example, when reading or verifying, it is also done by partition

1. Read 10 Blocks of partition 1 and save it to the file

2. Read 5 Blocks of partition 2 and save them to the file

3. Read finish.

By setting partitions flexibly, you can individually read or write data of one or more blocks.

6.4.9 Configuration Example 2 (K9F1208U0C)

Operation method: multiple files, partitions mode, replace bad blocks

K9F1208U0C parameter:

IC capacity: (512+16)*32*4096 blocks Page Size: 512 bytes Spare size: 16 bytes

Pages Per Block : 32 pages

Block Size : 4096

- 1) Use partition table to write NAND FLASH
- 2) Bad block handle mode: replace block, if bad blocks are found, write to block 4000# start position
- 3) File data: includes spare area
- 4) Use 2 partitions,

The first partition: from 1# to 1000#, a total of 1000 blocks, the actual length of the written data is 100 blocks. The second partition: from 2000# to 3999#, a total of 1000 blocks, the actual length of written data is 3 blocks

5) The written data file is: PART_1.BIN Partition 1

PART_2.BIN Partition 2.

6) Programming process is shown in Table 1-3.

-4. Fi	le na	ame / Path /	Block Assig	ined		
		Data a	ccess meth	iod: 🔿 Si	ingle File Mode ,All Datas	
				() s:	ingle File,Partitions Mode	
				💽 M1	ltiple Files and Partitions	Calcu. CRC32
Ter	npor	ary Buffe	r Floder:			Set Buffer Floder
D:	/ Xâl	pro_T56\Us	serData\NA	ND		
PAI	RT.	ST_BLK	END_BLK	CNT_BLK	File	
$\mathbf{\nabla}$	1	0	1000	100	D:\Xgpro_T56\UserData\NAND\Part_1.	bin
\mathbf{r}	2	2000	3999	3	D:\Xgpro_T56\UserData\NAND\Part_2.	bin
Т	3	0	0	0	D:\Xgpro_T56\UserData\NAND\Part_3.	bin
	4	0	0	0	D:\Xgpro_T56\UserData\NAND\Part_4.	bin
	5	0	0	0	D:\Xgpro_T56\UserData\NAND\Part_5.	bin
	6	0	0	0	D:\Xgpro_T56\UserData\NAND\Part_6.	bin
	7	0	0	0	D:\Xgpro_T56\UserData\NAND\Part_7.	bin
	8	0	0	0	D:\Xgpro_T56\UserData\NAND\Part_8.	bin

-7. Bad Block Handle Mode								
🔘 Skip Bad Block								
🕥 Hard Copy								
Replace Block @Block# 4000								

File		(512+16)x32bytes NAND Flash
File:Part_1		0# block RES
528x32 bytes		
528x32 bytes		1# Block 1th partition start
		2# block
528x32 bytes		
528x32 bytes		N# block
528x32 bytes		N+1# Bad Block
		N+2#
528x32 bytes		
528x32 bytes		Bad Block x
File:Part_2		
528x32 bytes		
528x32 bytes		2000# Block 2th Partition start
528x32 bytes		2001# Bad Block
528x32 bytes		2002#
		2003# Programming Over
		4000 # Replace Part1 N+1
		4001# Part1 bad block x
	\backslash	4002# Part2 2001#

6.5 Program NAND through ISP

ISP programming only supports SPI NAND IC, select X1 mode, check option <ICSP port> to program. ISP programming process is no different from using adapter. Do not separate the three wires, while connect the two GND lines and CLK clock lines.

6.6 Save project file

For all configuration parameters, you can "Save Project" to project file. When use it again, just open the project file and you can directly program. It is suitable for mass production.

6.7 NAND Flash Copy From Original Chip

6.7.1 Notes:

In repairing equipment, we often need to read out data from an original chip, copy it to another new chip, and then solder it to the board. To ensure that the chip can work properly, users need to pay attention to the following points:

- Copy chip configuration: Use the default settings of the programmer software. Option settings: must use hard copy, the data in the file must include spare area, all other options are not checked by default. When reading by this mode, the programmer can read the entire contents of the chip (including the contents of the bad block) to the file.
- 2. Some NAND FLASH chips have the unique ID. Embedded system applications may read the unique ID of the chip and perform encryption operations in the program, because the unique ID is set by the chip manufactory at the factory and cannot be changed or copied. In this case, even if you have copied all the contents of the chip correctly (including the OTP contents), it will not work properly after replacing with the new chip.

For example: MT29F4G08ABAEA has the unique ID (16+16 Bytes), which can only be read, cannot be rewritten. If the application is encrypted by this method, it cannot be replaced with the new chip unless you can modify the software of the embedded system.

3. OTP Area (OTP One-Time Programmable Storage Area)

OTP Area only exists on some NAND Flash chips, please check the IC data sheet for details.

For example: MT29F4G08ABAEA has the OTP data of 30 pages (30Pages*2112 bytes). When reading, you should read the OTP content at the same time. Check whether the OTP file is completely empty (FF), if there is OTP data, you need to write OTP at the same time when programming. Only T56 can support reading and writing OTP data.

Read the OTP content, as shown below:

5. Set OTP Area	
🔲 OTP PROTECTED After Programmi	Select OTP data file
D:\Xgpro\UserData\NAND\OTP_data.bin	
OTP Pages Per Die : 30	

6.7.2 Configuration and options

Default settings: hard copy, single file mode all data, Includes Spare Area (OOB)

6. Spare Area in the File	7. Bad Block Handle Mode
💿 Include Spare Area	🔿 Skip Bad Block
🔘 none	Hard Copy
	C Replace Block @Block# 0

6.7.3 Read the original chip and save

Click [Read] button in the toolbar to start reading the chip, as follows:

MODEL:	MT29F1G08ABAEAWF	- Location in Socket -	TSOP48_DIP4	B	
Use Adapter: TSOP48_DIP48 Save Log				Q	
Pins Detected Pass ID: 0x 2C F1Of D:Calcu.available of Reading Nand Flas Reading Nand OTP Data was saved to Verifing Nand Flas Verifing Nand OTP Verifing Succeede	ed! () isk capacity: 199 GB h : Succeeded. Time : 16.438 S Flash Siz : Succeeded. Time : 0.062 S OTP Size :6 the file: D:\Xgpro\UserData\NAND\OTP_da h : Succeeded. Time : 0.672 S Flash Size : Succeeded. Time : 0.015 S OTP Size :6 d	ze :135168 KB 51 KB ta.bin ∺135168 KB 51 KB	PIN 1#		
<	Read and Verify by	one key			
	Reading + Verifing Succeeded			1 1	
				ZIF48	

Exit the Read dialog box, Click [Save] button in the toolbar to save flash to a new file

6.7.46. Copy new chip

Selecting correct IC model, and [Load] the data file

Put on the new chip to the socket, click **[PROG.]** button in the toolbar, the following interface will pop up: click the **[PROG.]** button to start programming.

Chip Program APP Version: 10.75	
MODEL: MT29F1G08ABAEAWP	Location in Socket
Use Adapter: TSOP48_DIP48 Save Log	9
Pins Detected Passed! ID: 0x 2C F1OK! Erase NAND FLash : Succeeded. Time : 2156 ms Programming Nand Flash Byffer File Size: 135168KB Programming Nand Flash : Succeeded. Time : 0.828 S Flash Size :135168 KB Programming Nand OTP : Succeeded. Time : 0.000 S OTP Size :61 KB Verifing Nand Flash : Succeeded. Time : 0.438 S Flash Size :135168 KB Verifing Nand OTP : Succeeded. Time : 0.015 S OTP Size :61 KB Verifing completed Erase/Program/Verify	
Programming + Verifing Succeeded	
100% View Adpter Program BACK	ZIF48

Notes:

- 1. It is possible that the speed of programming the chip is faster than reading, because the software automatically skips the content of the empty data during programming.
- 2. In the process of reading, erasing, or programming, if chip has bad blocks, the tip will appear, but it does not affect the programming of the chip.
- 3. It is not necessary to check the bad block before copying. As long as the verifying is correct and there is no error when programming, the new copied chip will be available. If there is a bad block in the new chip, the software will skip writing if the bad block is empty data when copying. If the new chip has a bad block, and the original chip has data to be written to the location of this bad block, the data can't be written into this bad block, the programming error will occur. Please replace with another new chip, (the location of the new chip bad block is generally random).
- 4. Repairers usually do not know how to deal with bad blocks, so only copy directly with hard copy mode.

6.8 NAND internal ECC setting

Notes: (ECC option is disabled for chips without ECC function)

- All ECC is enabled by default, if you want, you can uncheck the option.
 Enable Internal ECC is the best choice, high reliability, the data read every time is the same, there is no bit flipping.
- 2. Enable ECC Read + Enable ECC Write, (same reliability as the original chip)
- 3. Enable ECC Read + Disable ECC write (data may be flipped, less reliable than original chip data)
- 4. Disable ECC Read + Enable ECC write (don't use this method)
- 5. Disable ECC Reading + Disable ECC writing, the probability of flipping is twice as high as the third method, and the possibility of error is greater, and the reliability is worse than that of the original chip data.
- 6. Chip has internal ECC correction, but the device does not use internal ECC correction, Must disable internal ECC when reading or writing. This situation should be rare, if reading and writing via enabled ECC, the chip does not work normally, test with [disable ECC read + disable ECC write]. ECC function switching is shown in the following figure:

Customize Setting					
Page Size :	2048 💌	VCC Voltage	:	3.0V	-
Spare Size :	128 👻	Bus Width	:	8 Bits	-
Pages per Block :	64 💌	PIN CONFIGURATION	:	ONFI STD	-
BlocksPer#CE(Die):	1024 👻	PACKAGE	:	WSON8	-
#CEn (Die) :	1 🔽	Internal ECC	:	Enable	•
#RBn Pins :	1 💌	Device ID :		2C 14	
View (Config Resault				

6.9 Calculation of NAND file address

Calculated in two cases:

- File includes Spare Area
 - The location of the data in the file = n Block x (Page Size + Spare Size) x the number of pages per block
- File does not include Spare Area
 Location of data in the file = n Block x Page Size x the number of pages per block

7. VGA_HDMI ISP and Tools

Only T56 programmer can support this function

7.1 VGA_HDMI ISP wiring diagram

Use the VGA_HDMI adapter to connect a VGA cable or HDMI cable, or ISP cable to the TV motherboard. When in-circuit programming, the TV motherboard is normally required to be in standby mode and to use external power supply. General wiring diagram as below:

According to the requirements of the motherboard, VGA in-circuit programming can be used in a variety of ways to connect. T56 can automatically recognize the hardware connection, do not need to make any settings in the software.



Connection photo via VGA cable



Connection photo via HDMI



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Connection photo via ISP:

GND -->VGA 10# or VGA shell / SDA -->VGA 12# / CLK -->VGA 15#



7.2 VGA_HDMI in-circuit programming

Note: VGA in-circuit programming 25 FLASH, currently only support **MSTAR** part of the motherboard, in the subsequent update will be gradually improved

Connected to the motherboard, power supply to the motherboard, keep TV in standby state

7.2.1 Auto-identify Chip

Click [AUTO] button, the dialog box will pop up, select VGA _HDMI_ISP port.

Click **[Detect]** button to automatically find the chip model and select the chip

🜆 Xgpro v10.75

File(F) Select IC(S) Project(P) Device(D) Tools(V) Help(H) Language(L)

🖆 LOAD 🖬 SAVE 🔊 auto 🦈 check 🕫 blank 📴 serify (READ + ADD RAM RAM	Ŧ
Select IC MST_EXT_W25Q32 @ISP_VGA	IC Information(No Project opened) ChipType: VGA_HDMI ChkSum: 0x20BE 6C09 IC Size: 0x400000 Bytes (4194304 Bytes) X	
Only for 8/16 Pins or VGA_HDMI_ISP 25series large capacity Flash Memory. after detecting completely, Push < Select > button to automatic selection Pin Counts or VGA_HDMI_ISP © 8 Pins © 16 Pins © VGA_HDMI_ISP 1 Model with the same ID was found please select one	XGecu® SN-ADP-VGA	-
Model: MSTAR MST_EXT_W25Q32 @ISP_VCA Manufactory MSTAR MST_EXT_W25Q32 @ISP_VCA Detect Select Cancel	VGA ISP-TTL-Port I I I I I I I I I I I I I I I I I I I	

7.2.2 In-circuit Read chip data

Click [Read] button, the read dialog box pops up, click [Read]

When reading, it will automatically find the motherboard communication port and protocol to enter SPI mode.



Read time 137 seconds, click [Back], please [Save] the data

7.2.3 VGA in-circuit programming

Click **[LOAD]** in the tool bar to load the data file to be written, as shown in the following figure:

File(F) Select IC(S)	Project(P) Device(D) Tools(V) H	elp(H) Lan	guage(L)	
😂 LOAD 🔛 SAVE	Oauto 📅 CHECK 🖻 BLANK 🗗 VERIFY	READ	+ ADD RA	M Erase
Select IC		-IC Informat	tion(No Project opened)	
MST_EXT	_W25Q32 @ISP_VGA	ChipType: IC Size:	VGA_HDMI ChkSum 0x400000 Bytes (4:	: 0x20BE 6C0 194304 Bytes
▶ 打开				×
$\leftarrow \rightarrow \neg \uparrow$	▌ > 此电脑 → 文档	√ Ö	搜索"文档"	Q
组织 ▼ 新建文	2件夹			•
□□ 此电脑	^ 名称 ^		日期	a^ (
	🤝 111.BIN		2018/7/16 12:54	E
	🤝 222.BIN		2019/4/19 17:51	E
1 视频	🛑 🤝 223.BIN		2019/5/8 11:14	E
■ 图片	IM29LV128.BIN		2019/2/25 9:43	E
🏭 文档	AM2011/200 BIN		2018/6/13 9:06	E
🕹 下载	🚿 MST_EXT_W25Q32@ISI	VGA.BIN	2021/1/30 14:24	E
▶ 音乐	VK-D.bin		2019/3/25 10:23	E 🗸
	v <			>
	文件名(N): MST_EXT_W25Q32@ISF	VGA.E ~	BIN Files(*.BIN)	~
	open		打开(0)	取消

After loading the file, click **[PROG.]** in the toolbar to bring up the programming dialog box. Click **[Program]** to start programming, as shown in the following figure:

Chip Program APP Version: 10.75 MST_EXT_W25Q32 Program Range – Location in Socket 🔽 FLASH Start Adr: 00000000 End Adr: 003FFFFF HDMI XGecu ® SN-ADP-VGA Use Adapter: SN-ADP-VGA Save Log Programming ...Succeeded Start search VGA_HDMI_ISP port... Respond Noral at Port: VGA (SDA->PIN12 SCL->PIN15) Enter SPI mode ... successful Device ID: EF 40 16 EraseSucceeded. Time : 7.046 S Programming FLASH ...Succeeded. Time : 120047ms 0 ISP-TTL-Port Verifing FLASH ...Succeeded. Time : 133218ms Programming ...Succeeded VGA എ E П RX/SD/ GND TX/SCL Erase/Program/Verify by one key View Adpter BACK Program

The whole programming process is completed

7.3 EDID Programming

Connect TV or monitor, click [Select IC] button, in the search device, type in "EDID".

Select	EDID	256B	@ISP	VGA.	as shown	below:
			<u> </u>			

Select Device		
Search Device	Manufactory	Device
EDID	ESTAR OTHERS	EDID 128B GISP_VGA
Type • ALL • ROM/FLASH/NVRAM • MCU/MPU • PLD/GAL/CPLD • SRAM/NVRAM • NAND • EMMC/EMCP • VGA/HDMI	OTHERS	1015 2363 013F VCA
Mistar		
MStar Semiconductor	IC Total: 26022	Select Cancel

After selecting, you can read, modify, program and verify the EDID.

The operation method is exactly the same as ordinary FLASH chips, so not describe here.

7.4 TV Tools: Serial Printing

Connect the TV board, click the icon in the upper right corner

Click the [Serial Print] button and T56 will get started to receive power-on diagnostic information from the TV board.

Turn on the TV power switch. The power-on information will be displayed on the screen, you can click [Save Log] to save.

The line sequence is auto found by default, do not need to select it manually.

Baud rate is 115200bps by default, please switch the baud rate if there is a messy code, as follows:

TV/LCD Monitor Tools				×
Information	Save Log	Clear	Fig. Adapter	
Note: 1. VGA / HDMI / ISP port 2. You can connect any or 3. Click <view adapter=""> t 4. Please switch baud rat [PORT:5] User termination!</view>	can be found automat he port to operate to see more possible te if there is garble	connection		XGecu [®] sn-adp-vga
<		>	VGA	ISP-TTL-Port (1)
Select Lines of Serials Port AUTO 1: VGA [RXD->12, TXD->15] 2: VGA [RXD->15, TXD->12] 3: VGA [RXD->4, TXD->11]	Baud Rates 115200 Bits/5 57600 Bits/5 38400 Bits/5 9600 Bits/5	Display Resul Color Patt	tion VGA: 640x480 -	60HZ • Bar •
 4: VGA [KAD->11, 1XD->4] 5: HDMI [RXD->16, TXD->15] 6: HDMI [RXD->15, TXD->16] 7: ISD [DYD > 5, TYD > 2] 	View Adapter		Vide	eo Signal Start
O 8: ISP [RXD-> 3, TXD-> 5]	, Read Monitor/TV Paran	neter	Serial Print BAC	κ.

Click [STOP] button to stop receiving messages.

7.5 TV tools: read monitor or TV parameters

Connect TV or monitor, power standby state.

TΥ

Click on the icon in the upper right corner, as below,

click on [Read Monitor/TV Parameter]

Show as follow:

Xgpro Software User Guide -T56/TL866II



7.6 TV tools: HDMI, VGA video test signal

Video test signal connection, you must use the T56 special SN-ADP-VGA adapter to connect VGA or HDMI

Click the icon

in the upper right corner of the window, click [Video Signal Start] button, various kinds of VGA or HDMI

signal will be out.

τv

TV/LCD Monitor Tools				×
Information	Save Log	Clear		
Note: 1. VGA / HDMI / ISP port can b 2. You can connect any one poi 3. Click <view adapter=""> to set 4. Please switch baud rate if [PORT:5] User termination! [PORT:5] User termination!</view>	oe found automat rt to operate e more possible there is garble	tically connection ed code wher		$\begin{array}{c} \textbf{X} \bigoplus \textbf{ecu}^{(R)}\\ \textbf{SN-ADP-VGA} \end{array}$
Select Lines of Serials Port Bac • AUTO • 1: VGA [RXD->12,TXD->15] • 2: VGA [RXD->15,TXD->12] • 3: VGA [RXD->4,TXD->11] • 4: VGA [RXD->11,TXD->4] • 5: HDMI [RXD->16,TXD->15] C	ud Rates 115200 Bits/5 57600 Bits/5 38400 Bits/5 9600 Bits/5 View Adapter	Display Resu Color Pat	ltion HDMI: 1280x720P ttern Vertical Color 1	-60HZ 💌 Bar 👻
6: HDMI [RXD->15, TXD->16] 7: ISP [RXD-> 5, TXD-> 3] 8: ISP [RXD-> 3, TXD-> 5]	Video is outputting Read Monitor/TV Paran	j(It may take a fe	w seconds for the display to res	pond) ()

Click [STOP] and back

8. Automatic Identification

The automatic-identification is for the SPI 25 series flash. Realize fast selection of 25 norflash chips. Identification interface: 8-pin and 16-pin chip on the ZIF socket, T56 supports VGA_HDMI ISP interface

8.1 ZIF Socket Identification

A .

Kgpro v10.75	") Decision of (D) D	evice/D) Teolo		Language(1)							—
LOAD 🕞 SAVE		E E	REAL		RÂM 🛃	rase PR	0G. 🏛	? about		АТ®)-т	TV
elect IC	AUTU - CA	ECK - BLANK - V		mation(No Project open	ed)	<u></u>			CALCU.		_
MT29F1G01A	BAFDWB(x4)(NW	(872) @PDFN8	← Chip1	ype: NAND Chk	Sum: Not Us	∋d				XGe	
Set Interface –				ize: 0x00_08800000	Bytes 1392t	4 KB				AUU	
IF socket	C ICSP p Aut	o Search 25 Flash	or VGA_HDI	MI_ISP)	<		Save Log Cl
	[¹	function description			_Location In	Socket			1		
201	NAND	Only for 8/16 capacity Elach Mar	Pins or VGA_	HDMI_ISP 25series large		Q_			Programme	r Connecte	************ ed.
-3. Customiz	e NANU par	Select > button to a	itomatic selecti	on			-	1	******	* * * * * * * * * *	* * * * * * * * * * * * *
🗌 Custor	nize Setti	Pin Counts or VGA	HDMI_ISP —						USB P	XGecu T56 OWER VOLT.	Ver: 00.01. AGE: 04.91V
	Page Size		6	8 Pins					USB SI	PEED MODE	: HS 480MHZ
2	pare Size		0	16 Pins					******	*******	********
Derer	non Bleek		C	VGA_HDMI_ISP					PageS	ize : 204	48
rages	per block	2 Model with the sa	me ID was four	d					es Per Blo	ıze : 120 ock : 64	8
BlocksF	er#CE(Die	blease select one							Blocks S:	ize : 128	BKB + 8KB
#	CEn (Die)								Device S:	ize : 10.	24 BMB + 8192KB
#	RBn Pins	Model: CERON	RN25T80						Bus Wid	dth: 8 Din: 1	
	M	lanufactory							nRB# 1	PIN: 1	
		-						1			
–4 File nam	e / Path / Blo	Detect	Select	Cancel							
											
	Vata access	method: () Si	ngle file ngle file	Mode ,All Datas							
								· · · · · · · · · · · · · · · · · · ·			
Block U	Unique ID	Options	Device.Int		Bloc	k @File:	0	▲ ▼			
puons		hand to				Note:	click the up	and down ar	rows to browse	the data of t	he previous block
Piri Detect	M C	NELK ID				the n	ext block				
Verify after		uto SN_NUM									
Skip Blank	Addr	.Range: 💿 ALL	O Sect								
Blank Check	Ox [<u></u>									
	L										
v				Default Programme	er(1): XGe	cu T56					0000 0000

- Select 8-pin or 16-pin chip
- Click [Detect], if the chip is recognized, the list of chip with the same ID will be displayed, select the appropriate one
- Click [Select] button in the dialog box, selecting IC is finished, next to reading or programming

8.2 VGA_HDMI In-circuit Identification

Click **[AUTO]** icon button in the toolbar to check "the VGA_HDMI ISP" interface. For details, see: Chapter 7 VGA_HDMI ISP in-circuit programming.

9. Digital Logic IC Testing

Functions:

- Test 54/74 series, CD4xxx digital logic chips, test results positioned to the pin. Adjustable VCC voltage.
- Automatically identify the logic chip.
- User-defined test vectors.

9.1 Test Logic Chip

Click [Logic Test] icon

Å⊒®)-Y i

in the toolbar to bring up the test dialog box, as below:



- After selecting IC model, directly click **[TEST]** button to see the test results of the chip vector
- VCC voltage is variable
- Click the [NEW] or [COPY] button to add a new customized chip
- The customized chips can be imported or exported for sharing. You can also delete or modify.

9.2 Customize the logic chip

Click [NEW] or [COPY] button to edit the logic test vector table, As figure shows:

New logic Device	×
Vector Table	
LINE 1 2 3 4 5 6 7 8 9 0 1 2 3 4 5 6 0001 1 H 1 H G C H 1 H V 0002 1 L 0 L G C L 1 H V 0003 0 L 0 L G C L 0 L V 0004 0 L 1 L G C L 1 L V	- Pins Vector Set
	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$
IC Model: IC Model: Pins Counter: 16 VCC Voltage: 5.0V Save New Back	

Modify and add the test vector table. then type in the new chip model and save the new.

9.3 Logic chip identification

Put the chip in the ZIF socket of the programmer and click [Auto Find], the logic matching chip model will be listed automatically, as below:



10. Add customized chips

- For chips that are not in the software support list, there are many chips that may have programming algorithms fully compatible with one of the chips in the list. In this case, you can add them to the custom list after the test is normal, so that you can easily use them later or export the list to share.
- For chips that the software support parameter setting, such as NAND, 27C and other series, various parameters can be set by user. The user can change the parameter settings, add it to user list after getting the programming test to pass.
- New customized chips can also be used as favorites of commonly used chips.

10.1 The common method of adding chips

The same type of chips may be the same programming algorithms exactly. But in general due to different manufactories, the identification ID of the chip is different, at this time, just select the compatible chip model, uncheck the option [check ID] to read and write for test.

10.1.1 **Test algorithm**

For example: XM25QH32B (assume, this chip is not in the support list)

We can select the same type of chip W25Q32BV for testing, as below:



As the above, the test is completed, that means the chip is programmed correctly by selecting W25Q32B.

STEP:

- 1) Select IC W25Q32BV
- 2) Load a data file
- 3) Uncheck the option [check ID]
- 4) program for testing
- 5) Erase, write and verify completed, if testing is correct, you can go to the next step. If it failed, you can select another similar chips for testing.

10.1.2 Read ID and add the chip model

As shown below:

Kapper v10.75 1.check ID File(F) Select IC(S) Project(P) Device(D)	eln(H) Language(L)	3. Add new			- 🗆 ×
DAD SAVE SAVE SAVE	(READ) + ADD	RAM Zaras	PROG.	🛿 🕈 ABOUT 📕	
ADD NEW IC	C Information(No Project of ChipType: EEPROM IC Size: 0x400000 B	opened) ChkSum: 0x1FE1 D4 ytes (4194304 Byte	180 s)	×	XGecu [®] Pro
XM25QH32B @SOIC8 N27C128A @DIP28 K9GAGO8UDE @TSOP48 XM25QH32B @SOIC8 N27C128A @DIP28 K9GAG08UDE @TSOP48	XMC SGS_THOMSO SAMSUNG XMC SGS_THOMSO SAMSUNG	Refrence : [Package : [MemorySize : [W25Q32BV SOIC8 4 MB		ammer Connected. ammer Connected. 1: XGecu T56 Ver: 00.0 JSB POWER VOLTAGE: 04.89 JSB SPEED MODE: HS 480MH ************************************
		Supported by [4.Enter n Model : [Manufacture : [Device ID : [UserName : [Note : [XGecu T56 / TL866II nodel/MFC XM25Q XM2 20 40	Plus C/ID H328 C	7 Size : 0x00400000 rice ID: 20 40 16 2. ID value
Note : Multiple choice with CTRL or SHIFT Key Apply Delete Im Im Verify after Auto SN_NUM Skip Blank Addr.Range: O ALL St	port Export Share	Sav Reduce clock fr	5.add	to user list Add New Back sing clip or wi	th ISP port]
Line Biank Crieck Ux 00000000 -> 003F Ready	Default Progra	ummer(1): XGecu	. T56		0000 0000

STEP:

- 1) Click [Check ID] to read the current chip ID
- 2) Display the current ID value
- 3) Click [ADD] in the toolbar
- 4) Type in the chip model, manufactory, the chip ID read, and other information
- 5) Click [Add New], a new model will be added in the user list
- 6) Just double click the chip model in the custom list to use it.

10.2 Add 27 series device

Example: M27C128A is not in the supported list, the basic method of adding chips is the same as before, more reliable method of adding is as below:

- 1. Select IC: Type in "27C128" to find, select AM27C128 @DIP28 Note: the chip package and chip capacity must be the same.
- 2. Download the M27C128A IC data set from the Internet

From the data sheet, you can find:

Chip ID: 20 0A, VCC=6.25V when programming, VCC=5V when verifying and reading, VPP=12.50V for programming, pulse time is 100us



Figure 7. Programming Flowchart

3. According to the parameters in data sheet, modify the chip parameters as shown below:

₩ Xgpro v10.75 - □ X
File(F) Select IC(S) Project(P) Device(D) Tools(V) Help(H) Language(L)
$\stackrel{\text{\tiny{(ab)}}}{=} \text{Eadd} = \text{Save} \left \bigotimes_{\text{auto}} \overline{\mathfrak{W}}_{\text{check}} \bigotimes_{\text{blank}} \overleftarrow{\mathbb{W}}_{\text{relify}} \left(\overline{\textbf{read}} \right) \right + \text{add} \overleftarrow{\mathbb{W}} = \left[\underbrace{\mathbb{P}}_{\text{rase}} \left[\overline{\textbf{Prog.}} \right] \left(\overleftarrow{\mathbb{W}} \right)^{2} \right] \\ \stackrel{\text{\tiny{(ab)}}}{=} \left[\underbrace{\mathbb{W}}_{\text{calcu}} \right] \\ \stackrel{\text{\tiny{(ab)}}}{=} \left[\underbrace{\mathbb{W}}_{\text{calcu}} \right] \left[$
Select IC [] IC Information(No Project opened)
AM27C128 @DIP28 ChipType: EEPROM ChkSum: 0x003F C000 XG @Cull IC Size: 0x4000 Bytes (16384 Bytes) XG @Cull XG @Cull XG @Cull
Set Interface Image: Set Interface <
Address 0 1 2 3 4 5 6 7 8 9 A B C D E F ASCII
0000-0000: FF
0000-0010: FF
0000-0020: FF
USB POWER VOLTAGE: 04.89V
0000-0050: FF
8888-8868: FF
0000-0070: FF
0000-0080: FF
0000-0090: FF
UUUU-UUHU: FF
0000-0000; FF
8888-88E8: FF
8088-89F8: FF
9898-9188: FF
ANNA-0110- FF
FLASH Devicenro
Options Config Informaton
Pin Detect Check ID
VPP Voltage: 12.50V VDD Write: 6.25V V
VCC Verify: 5.00V V Puls Delay: 100us V
▼ Skin Blank Arddr Ranner ⊙ All C Sert
Ready Default Programmer(1): XGecu T56 0000 0000 //

4. Click [ADD] button in the toolbar

In the following position, type in the chip model: M27C128A Manufactory: SGS-THOMSON Chip ID: 20 0A, as shown below:

click [Add new] button

XW250H32B 0SOTC8	XMC		
M27C128A @DIP28 K9GAGO8UOE @TSOP48	SGS_THOMSO SAMSUNG	Refrence :	AM27C128
XM25QH32B @SOIC8 M27C128A @DIP28 K9GAG08U0E @TSOP48	XMC SGS_THOMSO SAMSUNG	Package :	DIP28
		MemorySize ;	16 КВ
		Supported by	XGecu T56 / TL866II Plus
		Model :	M27C128A
		Manufacture :	ST
		Device ID :	200A
		UserName :	
		Note :	
Note : Multiple choice with CTRL or SHIET Key		S	ave Modify Add New

5. Double click the new chip to apply using it.
10.3 Add NAND chips

For NAND chips, theoretically you can customize all NAND chips. For ONFI standard chips, you can also automatically identify and add to the custom list. For non-ONFI standard chips, you can add it according to the IC data sheet.

10.3.1 Select a NAND chip of any type with the same package

K9GAG08U0E TSOP48 package chip as an example to add custom.

Arbitrarily select a K91G08U0M @TSOP48 (you can select any other TSOP48 NAND chip)

Electron Project(P) Device(D) TopIs(A) Help(H) Language(L)	- 🗆 X					
	Å⊒®)−γ τν					
Select IC K9F1G08U0M @TSOP48 IC Information(No Project opened) ChipType: NAND ChkSum: Not Used IC Size: 0x00_08400000 Bytes 135168 KB XGecu® Pro						
Image: Solid Constraint of the solid consolid consolid constraint of the solid constraint of th	Save Log Clear ************************************					
Block 0 U SAMSUNG Electronic IC Total: 26022	> >					
Options	the data of the previous					
□ Verify after □ Auto SN_NUM □ Skip Blank Addr.Range: ⓒ ALL ○ Sect □ Blank Check Ox 000000000 -> 00000000	o Identi.(ONFI)					
Ready Default Programmer(1): XGecu T56	0000 0000					





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From the above figure you can see,

K9GAG08U0E Parameter:

Page Size 8K (8192) Spare Size=436 Number of pages per block: 128 pages, total number of blocks 2076 blocks In addition, from data sheet you can find, the operating voltage is 3.3V 1CE pin, 1 RB pin, 8-bit data width

ID: EC D5 84 72 (only read the first 4 bytes)

10.3.3 Set NAND parameters

Click [Options] to set as below (3. Customize NAND parameters):

₩ ×gpro v10.75				- 🗆 ×	
File(F)					
🖆 LOAD 🖬 SAVE Đ _{anto} 🖽 Check 🤁 Blank 🏎 (READ + ADD RAM 📑 rase (PROG.) 🗒	🤰 🦓 авоит	CALCU.	А В	TV	
Select IC					
K9F1G08U0M @TSOP48			XGe	cu [®] Pro	
Set Interface © ZIF socket © ICSP port □ ICSP_VCC Enable Vcc current Imax: Default • • • •	6 Bits			Save Log Clear	
3. Customize NAND parameters					
Page Size : 8192 VCC Voltage : 3.0V V Spare Size : 436 2 Bus Width : 8 Bits V		USB POW USB SPE	ER VOLTA ED MODE: ********	GE: 04.89V HS 480MHZ	
Fages per Block : 128 V PIN CONFIGURATION : ONFI STD V		NAND CONFIG R	ESULT		
BlocksPer#CE(Die): 2076 - PACKAGE : TSOP48 -		PageSiz	e : 819	2	
#CEn (Die) : 1 Internal ECC : Disable	1	SpareSiz Pages Per Bloc	e: 436 k: 128		
#RBn Pins : 1		Blocks Siz Total Block	e : 1024 s : 2074	4KB + 54KB 6	
View Config Resault 3 Device Size : 2GB + 110MB Bus Width : 8 nCE# Pin : 1					
nRB# PIN : 1 4					
Data access method: Single File Mode .all Datas					
C Single File, Partitions Mode					
C Multiple Files and Partitions Calcu. CRC32	v	<		>	
Block 0 Unique ID Options Device.Info Block @File: 0	-				
Coptions Config Information					
Pin Detect Check ID Note: click the up and dow data of the previous block /	n arrows to br or the next blo	rowse the ock			
Displayer Actin Aranger @ Act O Sect Blank Check 0x 000000000 -> 000000000 ->			Auto Io	denti.(ONFI)	
Ready Detaute Programmer (1): AGECU 156				0000 0000	

- 1. Check option [customize setting]
- 2. Set value parameter according to IC data sheet
- 3. Click [View Config Result] and you can view the final result in the right information column [4].

10.3.3 Add to User List

After the parameters are set, add new list in the same way as before, click the **[ADD]** button in the toolbar to enter the ADD NEW IC dialog box, as below:

www.XGECU.com

XM25QH32B @SOIC8 M27C128A @DIP28	XMC SGS_THOMSO	Refrence :	K9F1G08U0M	
K9GAG08U0E @TSOP48 XM25QH32B @SOIC8 M27C128A @DIP28 K9GAG08U0E @TSOP48	SAMSUNG XMC SGS_THOMSO SAMSUNG	Package :	TSOP48	
		MemorySize :	1 GB	
		Supported by	XGecu T56 / TL866II Plus	
		Model :	K9GAG08U0E	
		Manufacture :	SAMSUNG	
		Device ID :	EC D5 84 72	
		UserName :	BLi	
		Note :		

Respectively type in the IC name, manufacturer and device ID. And click **[Add New]** to add to the list. Double click the added model, you can program the IC. If the read/write is normal, it means the addition is correct.

10.4 Import and Export Share

- For customized chips, user can export the database for sharing, just send the exported data file to the third party, who uses the import function to import the list.
- Export data, use CTRL or SHIFT key + left mouse button to multi-select and export multiple chips at one time. The extension of exported file is xxx.ULI.

10.5 Commonly-used chip favorites

For commonly-used chips, there is a drop-down list of the last 10 chips to the right of the [Select IC button]:

	₩ ×gpro v10.75
	File(F)
	🖻 load 🖬 save 🔊 auto 🏧 check 🕮 blank 🎰 i
	Select IC
	K9F1G08U0M @TSOP48
SAMSUNG	K9F1G08U0M @TSOP48
ESMT	F59L2G81A(2048+128) @VFBGA63 P_VCC Ena
WINBOND	W25Q32BV @SOIC8
AMD	AM27C128 @DIP28
MICRON	MT29F1G01ABAFDWB(x4)(NW872) @PDFN8
MICRON	MT29F1G08ABAEAWP @TSOP48
INTEL	RC28F512P30EF @BGA64
AUTO	AUTO EMMC(ISP)_1B_1.8V(recommend)
AUTO	AUTO EMMC_8B_1.8V @BGA153(recommend)
ATMEL	ATMEGA16A @DIP40
	Recent 10

If it is not enough to use, you can add to this custom list.

Selection method:

After selecting IC, directly click **[+ADD]** button in the toolbar, without modifying the content, directly add to the custom list. Next time, user can select the IC in the custom list. User can select the IC model more quickly.

11. Appendix

11.1 Disclaimer

- (1) Products that have been repaired, modified by any organization or individual not officially authorized by us are not covered by the warranty.
- (2) The ZIF socket of the product and other man-made damages are not covered by the warranty.
- (3) Joint and several extended liability caused by hardware failure or software defects.

Special Declare

Due to the variety of chips supported by the programmer and the complexity of the software system, errors or defects are inevitable. In mass production, especially for OTP one-time programming chips, you must make sure that the programming is correct before mass production. We are not responsible for collateral expansion losses due to hardware failure or software defects. If you find any problems or have valuable opinions about our products, please contact us.

11.2 Warranty

Within one year from the date of purchase, if there is a failure during normal operations, can repair for free.

11.3 Contact Us

As the software is constantly updated, the manual content is for reference only and is subject to the product application. The latest version software can be downloaded from <u>http://www.xgecu.com/en</u>.

Name: Haikou Xingong Electronic Co.,Ltd. Address: 4th Floor, Jingrun Hotel, No.80, Qiuhai Avenue West, Haikou, Hainan Province, China, Postal Code: 570311 EMIAL: 532007590@QQ.com TEL: 0898-68681816

11.4 FAQ (Frequently Asked Questions)

1) Device unavailable or error

It is usually because the USB driver is not installed, or the driver is prohibited by antivirus software, at this time the RUN light on the USB programmer flashes rapidly.

Solution: Refer to section 2.1 and re-install the application software.

2) Error when updating firmware, unable to refresh

It is usually caused by using a USB hub. Please do not use an external HUB when refreshing. Please directly connect the programmer to the USB port of your computer to refresh. Restart the computer to test. If it still cannot solve the problem, please try to do the refresh operation on another computer.

3) Poor pin contact

Situation 1: Old chips, often there are some tips of poor pin contact, need to handle with pins carefully.

Situation 2: If using an adapter, please use a multimeter to measure whether the adapter pins are normal.

Situation 3: Individual pins of individual chips may not support pin contact check. In this case, you can temporarily uncheck the option **<Pin Detect>** in the lower left corner of the main interface.

Note: Pin detect can only check if the pin is on, cannot check the contact resistance.

If the contact resistance is too large, especially for NAND high-speed chips, it will also cause working errors. So be sure to clean the adapter, please do not easily trust any clip-type connection.

Note: Pin detect can only check if the pin is on, but cannot detect the contact resistance. If the contact resistance is too large, especially for NAND high-speed chips, it will also cause working errors. So make sure to clean the adapter and please do not easily trust any clip-type connection. After clamping, hard twist the adapter so that there is a small amount of frictional sliding between cooper sheets of the ZIF socket and pin headers or between the pins of integrated circuit, to make a good contact.

4) Check ID error

Many chips have an internal chip identification mark (Identification). The content generally has two or more bytes, generally the first byte is the Manufacturer ID, followed by the chip type or chip capacity. Different chip has the different ID and the function of this option is to prevent incorrect chips put in. This option is to check the chip ID before reading or writing. If it is correct, continue. If ID incorrect, abort. This function is optional. The option is checked by default.

For the same type of chip, different manufactory may program in the same way. For chips not supported in the list, you can select same capacity same type ICs of other manufactories to program. Because ID is different, before programming, uncheck the option <Check ID>.

For few parts of microcontrollers, the chip ID cannot be read after chip is encrypted. At this time, the option <Check ID> should be unchecked in the main interface, otherwise check ID error will appear.

5) Programming for chips 27C series VPP voltage 21V or 25V

T56 directly supports up to 25V.

TL866II only supports programming voltage VPP up to 18V. For earlier 27C series ROMs, chips with VPP voltage of 21V and 25V are no longer supported for writing, but can be read. If used, you can replace with the same type of chips that their programming voltage are 13V or 12V. For example, 27C32 chip, its programming voltage is 21V or 13V. The chip can be directly replaced. Please do not use an external power supply to raise the voltage for forced programming. When the chip is damaged, the 21V/25V high voltage may run back into the programmer and there will be the hardware damage.